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CONTACT TYPE IMAGE SENSOR AND  
INFORMATION PROCESSING APPARATUS

BACKGROUND OF THE INVENTION

5 Field of the Invention

The present invention relates to a contact type image sensor which reads an original from light reflected therefrom and can be used as an image pickup device of a facsimile, a copier, a scanner, and the like, and to an information processing apparatus using such a contact type image sensor.

Related Background Art

As an example of an original reader used with a facsimile, a copier, a scanner, or the like, a contact type image sensor is known which focusses an image of the original at a magnification factor of 1 : 1 and reads the image having the same size as the original with a sensor array. Such a contact type image sensor is constituted of: a sensor substrate formed with a plurality of sensor chips each having a plurality of pixels for photoelectric conversion and a protective film for protecting the sensor chips; a rod lens array for focussing an image of an original upon pixels of the sensor chips; and a cover glass defining an original reading surface, respectively mounted on a frame.

Fig. 15 is a schematic perspective view of a

conventional contact type image sensor. Reference numeral 41 represents a frame for supporting the image sensor, and reference numeral 45 represents a transparent cover glass adapted to be in contact with an original and defining an original reading surface.

A plurality of optical sensors (pixels) are disposed along a longitudinal direction (main scan direction) DM of the frame 41, the shorter side direction DS being a sub-scan direction.

Figs. 16A to 16C are cross sectional views showing the structures of different image sensors taken along line 17-17 in Fig. 15. Each image sensor shown in Figs. 16A to 16C is constituted of: a light source 3 for illuminating an original; a rod lens array 2 disposed directly under an original reading surface of a cover glass 1; sensor chips 12; and a sensor substrate 18, respectively held in position by a frame 9. The image sensor shown in Fig. 16A has a bottom plate 8 integrally mounted on the frame 9 via a spacer 6. The image sensor shown in Fig. 16C has a transparent substrate 10 in place of the sensor substrate 18. In the image sensors shown in Figs. 16A and 16B, a sensor array 19 is constituted of the sensor substrate 18 and sensor chips 12. A ceramic or glass epoxy substrate is used as the sensor substrate 18. After the sensor chips 12 are disposed on the substrate 18, wire bonding is performed to form the sensor array 19. The configuration of the frame 9 and the

processing of the sensor substrate 18 have been determined so as to prevent stray light to be caused by external light and internally reflected light from entering sensor light reception areas. Other necessary components are also used for the image sensors shown in Figs. 16A and 16B.

In the contact type image sensor shown in Fig. 16C, in place of the sensor substrate 18, the transparent substrate 10 such as a glass substrate with electrical wiring connections is used. The sensor array 19 is formed by mounting a plurality of face-down sensor chips 12 for photoelectric conversion in one line on the transparent substrate 10. High work precision of the image sensor has been set in order to prevent stray light to be caused by external light and internally reflected light from entering sensor light reception areas, more than the sensor arrays shown in Figs. 16A and 16B.

Fig. 17 shows another example of the contact type image sensor shown in Fig. 15. A focussing unit 47 is disposed in a first space 41A of a frame 41. The focussing unit 47 has side plates 72 and 73 which allow a lens array of one or more lenses 71 to be disposed in rows. A light source 46 is disposed in a second space 41B. The light source 46 is constituted of: one or more LED light source units 63; a light guide plate 61 for guiding light from the light source along the main

scan direction DM and illuminating an original PP; and a housing 62 for intercepting leak light from the light guide plate 61 and positioning the light guide plate 61 to efficiently illuminate the original PP.

5           The first and second spaces 41A and 41B communicate with each other. A sensor array 43 is mounted on an electrical circuit substrate 44 and is disposed between the frame 41 and a frame 42 as a second support, facing a third space 41C.

10           This image sensor is assembled in the following manner. The light source 46 is fixed to a mount plane 41D with adhesive or screws, and the focussing unit 47 is inserted into the first space 41A and fixed to a mount plane 41E with adhesive or screws.

15           The electric circuit substrate 44 with the sensor array 43 is fixed to the frame 41 by using the frame 42 or by using adhesive or screws.

          With the above-described contact type image sensors, as shown in Fig. 18, in order to intercept a  
20   stray light beam 31 entering from a gap between a lens array and a frame, a stray light beam 32 entering from the bottom of each LED, and stray light beams entering from the sides and bottom of a sensor substrate, light interception walls are mounted on the frame, a gap is  
25   minimized with strict size precision, or other countermeasures are adopted. Therefore, components become complicated and bulky so that the assembly

performance is degraded. Manufacture cost becomes high because of an increase in the number of components such as a bottom plate and an internal reflection preventing process.

5           In the case of a contact type image sensor such as shown in Fig. 16C which is formed by mounting a plurality of face-down sensor chips for photoelectric conversion in one line on a transparent substrate such as a glass substrate with electrical wiring  
10 connections, the merits of the transparent substrate become demerits because of entrance of stray light.

          In order to further enhance and promote the compact structure and highest merit of the above-described contact image sensor, the following technical  
15 issues to be solved still exist.

          (1) As the focussing unit 47 shown in Fig. 17 is made compact, the coating area of adhesive 49 for fixing the focussing unit 47 to the frame 41 becomes small. Therefore, it becomes difficult to coat the  
20 adhesive 49, or the adhesive may permeate into the surface of the focussing lens 71 to block the focussing optical path so that light information of the original PP into the sensor array 43 is intercepted to thus lower the image quality.

25           (2) If there is a variation in assembly works of inserting the focussing unit into the first space 41A and fixing it to the mount plane 41E, a position

displacement of the focussing unit 47 from the mount plane 41E occurs so that the image quality is lowered.

#### SUMMARY OF THE INVENTION

5       An object of the present invention is to make compact a contact type image sensor. Another object of the invention is to improve an assembly performance of a contact type image sensor.

10       In order to achieve the above objects, according to one embodiment of the invention, there is provided a contact type image sensor comprising: a sensor substrate having photosensors mounted thereon; a focussing unit for focussing light from an original upon the photosensors; and a frame for holding the  
15       sensor substrate and the focussing unit, wherein the focussing unit abuts on the sensor substrate. With this embodiment, the contact type image sensor can be made compact.

20       According to another embodiment of the invention, there is provided a contact type image sensor comprising: photosensors; a support member for supporting an original; a focussing unit for focussing light from the original upon the photosensors; a frame for holding the photosensors, the focussing unit, and  
25       the transparent support member; and a focussing unit holding member disposed between the transparent support member and the focussing unit, for positioning the

focussing unit relative to the frame. With this embodiment, the assembly works of the contact type image sensor become easy.

Other objects and aspects of the present invention will become apparent from the following detailed description of embodiments when read in conjunction with the accompanying drawings.

#### BRIEF DESCRIPTION OF THE DRAWINGS

10        Fig. 1 is a cross sectional view of a contact type image sensor according to a first embodiment of the invention.

      Figs. 2A and 2B are cross sectional views of a sensor array of the image sensor of the first  
15        embodiment.

      Fig. 3 is a cross sectional view of a contact type image sensor according to a second embodiment of the invention.

      Fig. 4 is a cross sectional view of a contact type  
20        image sensor according to a third embodiment of the invention.

      Fig. 5 is a cross sectional view of a contact type image sensor according to a fourth embodiment of the invention.

25        Fig. 6 is a cross sectional view of a contact type image sensor according to a fifth embodiment of the invention.

Fig. 7 is a cross sectional view of a contact type image sensor according to a modification of the fifth embodiment of the invention.

5 Fig. 8 is a plan view of a contact type image sensor.

Fig. 9 is a cross sectional view taken along line 9-9 of Fig. 8.

10 Fig. 10 is a cross sectional view of a contact type image sensor according to a seventh embodiment of the invention.

Fig. 11 is a cross sectional view of a contact type image sensor according to an eighth embodiment of the invention.

15 Fig. 12 is a cross sectional view of a flat bed type image sensor according to a ninth embodiment of the invention.

20 Fig. 13 is a schematic cross sectional view of an image information processing apparatus using a flat bed type image sensor according to a tenth embodiment of the invention.

Fig. 14 is a schematic cross sectional view of an image information processing apparatus using the flat bed type image sensor of the tenth embodiment.

25 Fig. 15 is a schematic perspective view of a contact type image sensor according to related art.

Figs. 16A, 16B and 16C are cross sectional views of typical contact type image sensors.

Fig. 17 is a cross sectional view taken along line 17-17 in Fig. 15.

Fig. 18 is a diagram showing typical stray light entrance paths.

5        Figs. 19, 20, 21 and 22 are cross sectional views of modified embodiments of the contact type image sensor of the first embodiment of the present invention.

#### 10       DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

Fig. 1 is a cross sectional view of a contact type image sensor according to the first embodiment of the invention. In Fig. 1, reference numeral 1 represents a transparent cover glass plate on which an original is placed. Reference numeral 2 represents a rod lens array for guiding light reflected from an original. Reference numeral 3 represents a light source for illuminating an original. Reference numeral 4 represents a light emitting element such as LED serving as a light radiation unit of the light source 3. Reference numeral 5 represents a light guide plate for guiding light radiated from the light emitting element 4 along a longitudinal direction (main scan direction) and focussing the light upon an original reading point. Reference numeral 7 represents adhesive for bonding the cover glass plate 1 and rod lens array 2. Reference numeral 9 represents a frame of the contact type image

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sensor. Reference numeral 10 represents a light transmissive substrate disposed in contact with the bottom of the rod lens array 2 to hold it in position, and mounted with the image sensor including the light emitting element 4. Reference numeral 11 represents a light shielding layer which covers a surface area of the light transmissive substrate 10 on which components are not mounted, in order to eliminate stray light beams. Reference numeral 12 represents sensor chips for receiving light reflected from an original and transmitted through the rod lens array 2 and light transmissive substrate 10. Reference numeral 13 represents a light receiving area of each sensor chip 12. Reference numeral 14 represents a sealing/bonding resin for covering the sensor chips 12. Reference numeral 19 represents a sensor array including the light transmissive substrate 10 and sensor chips 12. Reference numeral 20 represents a roller for pressing an original 21 moved relative to the contact type image sensor, against the cover glass plate 1.

In this embodiment, since the rod lens array 2 as a focussing unit is aligned in position by abutting it on the light transmissive substrate 10, the contact type image sensor can be made compact in its thickness direction.

The contact type image sensor of this embodiment will be described more in detail. A plurality of face-

down sensor chips 12 for photoelectric conversion are mounted in line and electrical wiring connections between the sensor chips and external terminals are formed. The light shielding layer 11 is made of black paint printed on the surface area of the light shielding substrate 10 except the areas corresponding to the light receiving areas of the plurality of sensor chips 12 and the area corresponding to the rod lens array 2. Unnecessary stray light beams can therefore be prevented from entering optical paths. The light shielding layer 11 may be a metal deposition film of aluminum or the like.

Figs. 2A and 2B are diagrams showing the outline structure of the sensor array 19. The light shielding layer 11 is made of black paint printed on the surface area of the light shielding substrate 10 except the areas corresponding to light receiving areas 300 of the plurality of sensor chips 12 and the area corresponding to a light output area 400 of the rod lens array 2. The plurality of sensor chips 12 for photoelectric conversion are mounted in line in a face-down position to face the light receiving areas 300 toward the light transmissive substrate 10, and electrical wiring connections between the sensor chips and external terminals are formed. The total area of the light receiving areas 300 is smaller than the light output area 400.

Fig. 3 is a cross sectional view of a contact type image sensor according to the second embodiment of the invention. A plurality of face-down sensor chips 12 for photoelectric conversion are mounted in line on a light transmissive substrate 10 and a light emitting element such as LED of a light source 3 and the like are mounted on the opposite surface of the light transmissive substrate 10, electrical wiring connections between these components being provided.

Similar to the first embodiment, a light shielding layer 11 is made of black paint printed on the surface area of the light shielding substrate 10 made of, for example, glass, except the areas corresponding to light receiving areas 13 of the plurality of sensor chips 12 for receiving light from an original and the area corresponding to a light output area of a rod lens array 2. The light shielding layer 11 may be formed on the outer surface of a sealing/bonding resin 14 (refer to Fig. 1) and on the outer surface of the rod lens array 2 except the optical path area of light reflected from an original 21 (refer to Fig. 1).

Fig. 4 is a cross sectional view of a contact type image sensor according to the third embodiment of the invention. In this contact type sensor array, a frame 9 is configured so as to perfectly shield light from opposite end surfaces of a sensor array 19. Light receiving areas for receiving light reflected from an

original 21 are disposed on the surface of a light transmissive substrate 10 on the bonding side between the substrate 10 and sensor chips 12. A light shielding layer 11 is made of black paint printed on the surface area of the light shielding substrate 10 except the areas corresponding to the light receiving areas, the area corresponding to a light output area of a rod lens array 2 on the side opposite to the bonding side, and the opposite end surfaces of the sensor array 19. Also in this embodiment, unnecessary stray light beams can be prevented from entering optical paths. The light shielding layer 11 may be made of a metal deposition film such as aluminum.

Fig. 5 is a cross sectional view of a contact type image sensor according to the fourth embodiment of the invention. This embodiment is applied to a contact type image sensor of the type that although a frame 9 is configured so as to perfectly shield light from opposite end surfaces of a sensor array 19, stray light from an original side cannot be eliminated perfectly (light entering a gap A on the side of a rod lens array 2). A light shielding layer 11 is made of black paint printed on the surface area of the light shielding substrate 10 except the areas corresponding to light receiving areas of sensor chips 12 for receiving light reflected from an original, the area, except a stray light entering area, corresponding to a light output

area of a rod lens array 2 on the side opposite to the sensor chip side, and the opposite end surfaces of the sensor array 19. Also in this embodiment, unnecessary stray light beams can be prevented from entering optical paths. The light shielding layer 11 may be made of a metal deposition film such as aluminum.

Fig. 6 is a cross sectional view of a contact type image sensor according to the fifth embodiment of the invention.

In this contact type image sensor, a plurality of face-down sensor chips 12 for photoelectric conversion are mounted in line on a light transmissive substrate 10 made of, for example, glass, and electrical wiring connections between the sensor chips and external terminals are formed. A frame 9, which aligns in position and holds a sensor array 19, a rod lens array 2 for focussing light from an original 21, a light source 3 for illuminating an original, and a cover glass 1 for supporting an original, can perfectly shield light from the opposite end surfaces of the sensor array 19 and also perfectly shield stray light from the original side. A light shielding layer 11 is made of black paint printed on only the surface area of the light shielding substrate 10 on the sensor chip side except the areas corresponding to light receiving areas of the sensor chips 12 for receiving light reflected from an original. Also in this embodiment,

unnecessary stray light beams can be prevented from entering optical paths. The light shielding layer 11 may be also made of a metal deposition film such as aluminum.

5           Fig. 7 shows a modification of the fifth embodiment. In this contact type image sensor, a frame 9 can perfectly shield stray light on the original side entering from a glass plate and a combination of the frame 9 and a bottom plate 8 can perfectly shield stray  
10   light such as external light. A light shielding layer 11 is made of black paint printed on only the surface area of the light shielding substrate 10 on the sensor chip side except the areas corresponding to light receiving areas of the sensor chips 12 for receiving  
15   light reflected from an original. Also in this embodiment, unnecessary stray light beams can be prevented from entering optical paths, even if the frame 9 and bottom plate 8 are not subject to an internal irregular reflection preventing process.

20           In the above-described embodiment, the LED is used as the light source. However, electroluminescence (EL) may be also used as the light source. Each of Figs. 19 to 22 shows such an embodiment where the EL is used as the light source. Fig. 19 shows an embodiment where an  
25   EL light source 144 of an array type is used. Fig. 20 shows an embodiment where the EL light source 144 is arranged on a back surface of a cover glass 1. Fig. 21

shows an embodiment where the EL light source 144 is arranged on the same surface as the surface on which the sensor 12 of the light transmissive substrate 10, which is a portion of the sensor array, is arranged.

5 Fig. 22 shows an embodiment where the EL light source 144 is arranged on the same surface as the surface the sensor 12 of the light transmission substrate 10 is arranged and wherein a reflection mirror 102 is arranged to switch an optical path within the image  
10 sensor and thereby attain the contact type image sensor of smaller size. Accordingly to the embodiments shown in Figs. 19 to 22, in which the EL is used as the light source, it can be attained to reduce the size of the contact type of the image sensor.

15 Figs. 8 and 9 are a plan view and a cross sectional view specifically illustrating the features of a contact type image sensor according to the sixth embodiment of the invention. Fig. 8 is a plan view of the contact type image sensor as viewed from an  
20 original reading surface of a transparent member 45 in contact with an original PP, and particularly shows the positions in a longitudinal direction DM of focussing unit holding members 48 for holding a focussing unit 47 for focussing light onto image sensors 43, the light  
25 entering via the transparent member 45 such as a glass plate from an original. The focussing unit holding members 48 hold the focussing unit 47 at a plurality of

positions thereof, by using a frame 41. Like elements to those shown in Figs. 15 and 17 are represented by using identical reference numerals, and duplicate description is omitted. Fig. 9 is a cross sectional view taken along line 9-9 of Fig. 8.

Referring to Fig. 9, a focussing unit 47 is disposed in a first space 41A of a frame 41. The focussing unit 47 has side plates 72 and 73 which allow a lens array of one or more lenses 71 to be disposed in rows. A light source 46 is disposed in a second space 41B. The light source 46 is constituted of: one or more LED light source units 63; a light guide plate 61 for guiding light from the light source along the main scan direction DM and illuminating an original PP; and a housing 62 for intercepting leak light from the light guide plate 61 and positioning the light guide plate 61 to efficiently illuminate the original PP.

The first and second spaces 41A and 41B communicate with each other. The sensor array 43 is mounted on an electrical circuit substrate 44 and is disposed between the frame 41 and a frame 42 as a bottom plate of a second support, facing a third space 41C.

This image sensor is assembled in the following manner. The light source 46 is fixed to a mount plane 41D of the frame 41 with adhesive or screws, the focussing unit 47 is inserted into the first space 41A

and abutted on a mount plane 41E, and the focussing unit holding members 48 are inserted into the space between the frame 41 and focussing unit 47 and fixed to the frame 41 with adhesive or screws.

5           The electric circuit substrate 44 with the sensor array 43 is fixed to the frame 41 by using the bottom frame 42 or by using adhesive or screws.

          Also referring to Fig. 9, the focussing unit 47 is held in position by being squeezed by the frame 41 and focussing unit holding member 48. The focussing unit holding member 48 is colored black same as the frame 41. The side wall 73 constituting the focussing unit 47 on the side opposite to the light source 46 abuts on the focussing unit holding member 48 which is fixed to the frame 41 with adhesive 49.

          A method of fixing the focussing unit holding member 48 to the frame 41 is not limited only to the above-described method. For example, convex and concave hooks may be provided to engage the focussing unit holding member 48 with the frame 41, or a pressure boss may be provided to either the focussing unit holding member 48 or the frame 41 to pressure-fix them.

          A surface 81 of a projecting portion of the focussing unit holding member 48 pressing downward the focussing unit 47 in a thickness direction or focussing optical path direction (up/down direction in Fig. 9) extends outward relative to a focussing opening angle

74 of the focussing unit 47. The focussing opening angle 74 defines a range allowing light reflected from an original PP to be received.

Referring to Fig. 8, the focussing unit 47 is held  
5 in position by being squeezed between the focussing unit holding members 48 and frame 41 at a middle and opposite end positions along the longitudinal direction DM. The number of positions where the focussing unit 47 is held may be one or more along the longitudinal  
10 direction, or the focussing unit 47 may be held over its whole length.

With the structure of the sixth embodiment, the following advantages can be obtained.

(1) Since the focussing unit 47 is positioned and  
15 squeezed between the frame 41 and focussing unit holding members 48, a position displacement of the focussing unit 47 to be caused by a variation in assembly works can be managed by a component dimension precision of the frame 41. Therefore, an image quality  
20 can be improved and a clear image can be maintained.

(2) Since the focussing unit 47 is fixed by fixing the focussing unit holding member 48 to the frame 41 with the adhesive 49, the adhesive 49 is prevented from being attached to the focussing unit 47  
25 and the focussing lens 71 will not be made dirty by the adhesive 49. It is therefore possible to solve a problem of a poor image quality by preventing a

focussing optical path from being shielded and preventing light information to image sensors from being cut.

5        Abutting the focussing unit holding member 48 only upon the side wall 73 without covering the focussing lens 71 of the focussing unit 47 can be managed by a component dimension precision of the focussing unit holding member 48. It is therefore possible to solve a problem of a poor image quality by preventing a  
10       focussing optical path from being shielded and preventing light information to image sensors from being cut.

(3) The focussing unit holding member 48 is colored black same as the frame 41, the black absorbing  
15       light and suppressing reflection light. It is therefore possible to solve a problem of a poor image quality by suppressing internal reflection light of the sensor array 43 and making uniform the internal reflection light.

20       Further, the surface 81 of a projecting portion of the focussing unit holding member 48 pressing downward the focussing unit 47 in a thickness direction or focussing optical path direction extends outward relative to the focussing opening angle 74 of the  
25       focussing unit 47. Since the surface 81 is retracted from a range allowing light reflected from an original to be received, an image quality can be prevented from

being degraded by internal reflection light.

In the sixth embodiment, similar to the first to fourth embodiments, a light shielding layer may be formed on an area surrounding the image sensors 43 on an electric circuit substrate 44 and on an area of the third space 41C between the frames 41 and the bottom frame 42 as the second support. In this manner, stray light other than image signal light from the frame 41 can be shielded so that only reflection light guided by the focussing unit 47 can be received with the image sensors 43 and an image signal having a clear and high contrast can be obtained.

Fig. 10 is a cross sectional view of a contact type image sensor according to the seventh embodiment of the invention. Referring to Fig. 10, a focussing unit holding member 48 abuts on a focussing unit 47 and on a transparent member 45 in contact with an original PP moving relative to the image sensor. A focussing optical path thickness of the focussing unit holding member 48 between the transparent member 45 and focussing unit 47 is set so that the surface of the transparent member 45 in contact with an original PP is positioned at the focal length TC of the focussing unit 47 in a range of a depth L of focus.

The focussing unit 47 is squeezed between the frame 41 and the transparent member 45 via the focussing unit holding member 48 along the focussing

optical path direction. While the focussing unit 47 is pressed down, the transparent member 45 is adhered to the frame 41 so that the focussing unit 47 is fixed.

With this structure, the mount position of the focussing unit 47 can be controlled by the component dimension precision of the focussing unit holding member 48 and frame 41. A position displacement of the focussing unit 47 from a mount position 41E to be caused by a variation in assembly works can be suppressed so that a problem of degraded image clearness can be solved.

Since the focussing unit 47 is held in position by the process of fixing the transparent member 45, the assembly process can be simplified and the number of assembly processes can be reduced.

Fig. 11 is a cross sectional view of a contact type image sensor according to the eighth embodiment of the invention. Referring to Fig. 11, a portion of a focussing unit holding member 46 abutting on a focussing unit 47 and on a transparent member 45 has a symmetrical shape along its longitudinal direction as viewed in the cross section. The focussing unit holding member 48 is a solid having an arrow shape. A frame 41 abuts on the top surface of the focussing unit 47 and the bottom of the arrowhead of the focussing unit holding member 48, and the transparent member 45 abuts on the top flat surface of the arrowhead of the

focussing unit holding member 48 and is fixed with adhesive 49.

With this structure, the assembly direction of the focussing unit holding member 48 becomes  
5 omnidirectional so that the assembly process can be simplified and the number of assembly processes can be reduced.

Fig. 12 is a cross sectional view of a flat bed type image scanner used as an information processing  
10 apparatus according to the ninth embodiment of the invention.

Referring to Fig. 12, the flat bed type image scanner is structured so that an original PP is read while a contact type image sensor moves relative to a  
15 transparent member 51 in contact with the original PP. A focussing unit 47 is squeezed between a frame 41 and a focussing unit holding member 48. The focussing unit 47 is held in position by fixing the focussing unit holding member 48 to the frame 41 with adhesive 49.

20 The focussing unit holding member 48 abuts on the transparent member 51 and focussing unit 47. A focussing optical path thickness of the focussing unit holding member 48 between the transparent member 51 and focussing unit 47 is set so that the surface of the  
25 transparent member 51 in contact with an original PP is positioned at the focal length TC of the focussing unit 47 in a range of a depth L of focus.

With this flat bed type image scanner, the contact type image sensor can move along a DS direction while the focussing unit holding member 48 abuts on the transparent member 51. The material of the focussing unit holding member 48 is mold resin having good slide and antifriction characteristics.

With this structure of the flat bed type image scanner, a position displacement of the focussing unit 47 to be caused by a variation in assembly works can be suppressed so that a problem of degraded image clearness can be solved. The focussing lens 71 will not be made dirty by adhesive so that it is possible to solve a problem of a poor image quality. It is also possible to set the contact type image sensor at a proper position relative to the read surface of the transparent member 51 during an original scan operation.

Fig. 13 is a cross sectional view of a facsimile with a communication function used as an image information processing apparatus having a contact type image sensor unit 100, according to the tenth embodiment of the invention. In Fig. 13, reference numeral 102 represents a paper feed roller as feeding means for feeding an original PP to a read position, and reference numeral 104 represents a separation piece for reliably separating originals PP one piece after another. Reference numeral 106 represents a platen

roller as transport means disposed at the read position  
and facing the sensor unit 100 for regulating the  
position of the read surface of the original PP and  
transporting the original PP. The sensor unit 100 is  
5 the contact type image sensor of any one of the above-  
described embodiments and has a transparent member such  
as a glass plate on the surface thereof in contact with  
the original PP. Light reflected from the original PP  
is read with the sensor unit via a focussing unit to  
10 thereby read an image of the original PP.

Reference symbol P represents a recording medium  
such as paper in a roll. Image information read with  
the sensor unit or image information transmitted from  
an external apparatus is reproduced and recorded on the  
15 recording medium. Reference numeral 110 represents a  
recording head as recording means for forming an image,  
reference numeral 112 represents a platen roller as  
transport means for transporting the recording medium P  
to a record position of the recording head 110 and  
20 regulating the position of a record surface of the  
recording medium P.

Reference numeral 120 represents an operation  
panel having switches as input/output means, a display  
for displaying a message or a state of partner  
25 apparatuses, and the like. Reference numeral 130  
represents a system control board as control means.  
The system control board 130 is provided with: a

control unit for controlling every units constituting the facsimile; drive circuits for a light source of the contact type image sensor 100 and for photoelectric conversion elements; an image processing unit for  
5 performing predetermined processes for image information supplied from the image sensor; a transmission/reception unit for transmitting image information processed by the image processing unit to a partner apparatus and supplying image information  
10 received from a partner apparatus to the image processing unit; and the like. Reference numeral 140 represents a power source of the facsimile. The drive circuits, image processing unit, and transmission/reception unit are controlled by the  
15 control unit.

Fig. 14 is a cross sectional view of a flat bed type image scanner as an image information processing apparatus using the contact type image sensor unit 100 of the tenth embodiment. Reference numeral 51  
20 represents a transparent member for defining a read surface in contact with an original PP. Reference numeral 201 represents a scanning belt as feed means for mounting the sensor unit 100 and scanning it in a scan direction DS. Reference numeral 202 represents a feed roller for driving the scanning belt 201.  
25 Reference numeral 230 represents a system control board as control means. The system control board 230 is

provided with: a control unit for controlling every  
units constituting the image scanner; drive circuits  
for a light source of the contact type image sensor 100  
and photoelectric conversion elements; an image  
5 processing unit for performing predetermined processes  
for image information supplied from the image sensor  
100; a transmission/reception unit for transmitting  
image information processed by the image processing  
unit to a partner apparatus and receiving various  
10 commands from a partner apparatus; and the like.  
Reference numeral 240 represents a power source of the  
image scanner. The drive circuits, image processing  
unit, and transmission/reception unit are controlled by  
the control unit. The sensor unit 100 moves in the  
15 sub-scan direction of the scanning belt relative to the  
original PP placed on the flat bed type transparent  
member 51 and reads one line in the main scan direction  
or depth direction of Fig. 14 to thereby read an image  
of the original in the read surface area. The sensor  
20 unit 100 is scanned while a focussing unit holding  
member 48 described with reference to Fig. 12 is moved  
in contact with the transparent member 51. Light  
reflected from the original PP is received with a line  
image sensor or sensor unit 100 via a focussing unit  
25 and converted into an image signal. The image signal  
is subject to the image signal process by the system  
control board 230 and is output to an external signal

processing apparatus.

Both the light shielding layer described in the first to fourth embodiments and the focussing unit holding member for positioning and fixing the focussing unit described with the fifth to eighth embodiments are  
5 provided to obtain synergetic effects thereof.

As described so far in each of the embodiments, the focussing unit for focussing light from an original upon sensor chips of the sensor array abuts on the  
10 sensor array. Accordingly, the contact type image sensor can be made light and compact, and in particular the image sensor can be made thin.

Further, the transparent substrate is covered with the light shielding layer in an area except the area  
15 corresponding to the light reception areas of the sensor chips and the area corresponding to the focussing area of the rod lens array. It is therefore possible to prevent leak light into the sensor chips and it is not necessary to shield the stray light  
20 entering paths with the structure of the frame or with other components. Accordingly, the degree of freedom of shapes of the components can be broadened, the number of components can be reduced, the image sensor and apparatuses using the image sensor can be made  
25 light and compact, and an application field of a face-down mounted sensor array can be expanded.

Furthermore, in order to align the focussing unit

with the frame, the focussing unit is squeezed between the focussing unit holding member and transparent member. Accordingly, adhesive will not make the surface of the focussing unit dirty, a mount position  
5 displacement of the focussing unit to be caused by a variation in assembly works can be suppressed, and the image quality can be maintained without degrading its clearness.

Many widely different embodiment of the present  
10 invention may be constructed without departing from the spirit and scope of the present invention. It should be understood that the present invention is not limited to the specific embodiments described in the specification, except as defined in the appended  
15 claims.



WHAT IS CLAIMED IS:

1. A contact type image sensor comprising:

(a) a sensor substrate having photosensors mounted thereon;

5 (b) a focussing unit for focussing light from an original upon the photosensors; and

(c) a frame for holding said sensor substrate and said focussing unit,

10 wherein said focussing unit abuts on said sensor substrate.

2. A contact type image sensor according to claim 1, wherein said sensor substrate is a transparent substrate.

15

3. A contact type image sensor according to claim 2, wherein said transparent substrate has a light shielding layer.

20 4. A contact type image sensor according to claim 2, wherein said focussing unit is disposed on said transparent substrate on a side opposite to a side where the photosensors are mounted.

25 5. A contact type image sensor according to claim 4, wherein said transparent substrate has a light shielding layer.





6. A contact type image sensor according to claim 5, wherein said transparent substrate is not covered with the light shielding layer in an area corresponding to a focussing area of said focussing unit.

5

7. A contact type image sensor according to claim 5, wherein said transparent substrate is not covered with the light shielding layer in an area corresponding to an area where the photosensors are mounted and in an area corresponding to a focussing area of said focussing unit.

10

8. A contact type image sensor according to claim 7, wherein the light shielding layer is formed so that an area of the focussing area of said focussing unit becomes smaller than an area of light reception pixels of the photosensors.

15

9. A contact type image sensor according to claim 1, wherein said focussing unit is a rod lens.

20

10. An information processing apparatus comprising:

a contact type image sensor for reading an original image and outputting an image signal;

25

processing means for performing a predetermined process relative to the image signal output from said





contact type image sensor; and

control means for controlling said contact type image sensor and said processing means,

wherein said contact type image sensor comprises:

- 5 a sensor substrate having photosensors mounted thereof;  
a focussing unit for focussing light from an original  
upon the photosensors; and a frame for holding said  
sensor substrate and said focussing unit, wherein said  
focussing unit abuts on said sensor substrate.

10

11. An information processing apparatus according to claim 10, wherein said sensor substrate is a transparent substrate.

15

12. An information processing apparatus according to claim 11, wherein said transparent substrate has a light shielding layer.

20

13. An information processing apparatus according to claim 11, wherein said focussing unit is disposed on said transparent substrate on a side opposite to a side where the photosensors are mounted.

25

14. An information processing apparatus according to claim 13, wherein said transparent substrate has a light shielding layer.





15. An information processing apparatus according to claim 14, wherein said transparent substrate is not covered with the light shielding layer in an area corresponding to a focussing area of said focussing unit.

16. An information processing apparatus according to claim 14, wherein said transparent substrate is not covered with the light shielding layer in an area corresponding to an area where the photosensors are mounted and in an area corresponding to a focussing area of said focussing unit.

17. An information processing apparatus according to claim 16, wherein the light shielding layer is formed so that an area of the focussing area of said focussing unit becomes smaller than an area of light reception pixels of the photosensors.

18. An information processing apparatus according to claim 10, wherein said focussing unit is a rod lens.

19. A contact type image sensor comprising:  
(a) photosensors;  
(b) a support member for supporting an original;  
(c) a focussing unit for focussing light from the original upon the photosensors;





(d) a frame for holding said photosensors, said focussing unit, and said support member; and

(e) a focussing unit holding member disposed between said support member and said focussing unit,  
5 for positioning said focussing unit relative to said frame.

20. A contact type image sensor according to claim 19, wherein said focussing unit is inserted into  
10 a space between, and squeezed between, said focussing unit holding member and said frame.

21. A contact type image sensor according to claim 19, wherein said support member is fixed to said  
15 frame with adhesive.

22. A contact type image sensor according to claim 21, wherein said support member together with said focussing unit holding member is fixed to said  
20 frame with adhesive.

23. A contact type image sensor according to claim 19, wherein said focussing unit holding member is positioned outside of an opening angle of said  
25 focussing unit.

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24. A contact type image sensor according to claim 19, wherein a thickness in an optical path direction of said focussing unit holding member between said support member and said focussing unit is set so  
5 that an original support surface of said support member is positioned in a range of a depth of focus of said focussing unit, and said focussing unit holding member abuts on said support member and said focussing unit.

10 25. An information processing apparatus comprising:

a contact type image sensor for reading an original image and outputting an image signal;

15 processing means for performing a predetermined process relative to the image signal output from said contact type image sensor; and

control means for controlling said contact type image sensor and said processing means,

wherein said contact type image sensor comprises:

20 photosensors; a support member for supporting an original; a focussing unit for focussing light from the original upon the photosensors; a frame for holding said photosensors, said focussing unit, and said support member; and a focussing unit holding member  
25 disposed between said support member and said focussing unit, for positioning said focussing unit relative to said frame.





26. An information processing apparatus according to claim 25, wherein said focussing unit is inserted into a space between, and squeezed between, said focussing unit holding member and said frame.

5

27. An information processing apparatus according to claim 25, wherein said support member is fixed to said frame with adhesive.

10

28. An information processing apparatus according to claim 27, wherein said support member together with said focussing unit holding member is fixed to said frame with adhesive.

15

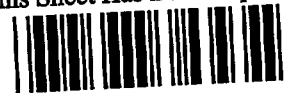
29. An information processing apparatus according to claim 25, wherein said focussing unit holding member is positioned outside of an opening angle of said focussing unit.

20

30. An information processing apparatus according to claim 25, wherein a thickness in an optical path direction of said focussing unit holding member between said support member and said focussing unit is set so that an original support surface of said support member is positioned in a range of a depth of focus of said focussing unit, and said focussing unit holding member abuts on said support member and said focussing unit.

25





# ABSTRACT OF THE DISCLOSURE

In a contact type image sensor having a sensor array mounting photosensors, a focussing unit for focussing light from an original upon the photosensors, and a frame for holding in position the sensor array and focussing unit, the focussing unit abuts on the sensor array. In a contact type image sensor having a sensor array having a plurality of face-down sensor chips with a plurality of pixels mounted on a transparent substrate in line, a rod lens array for focussing light from an original, a light source for illuminating the original, and a frame for holding in position the sensor array, rod lens array, the transparent substrate is covered with a light shielding layer in an area other than an area on which the pixels of the sensor chips are mounted and an area corresponding to a focussing area of the rod lens array.

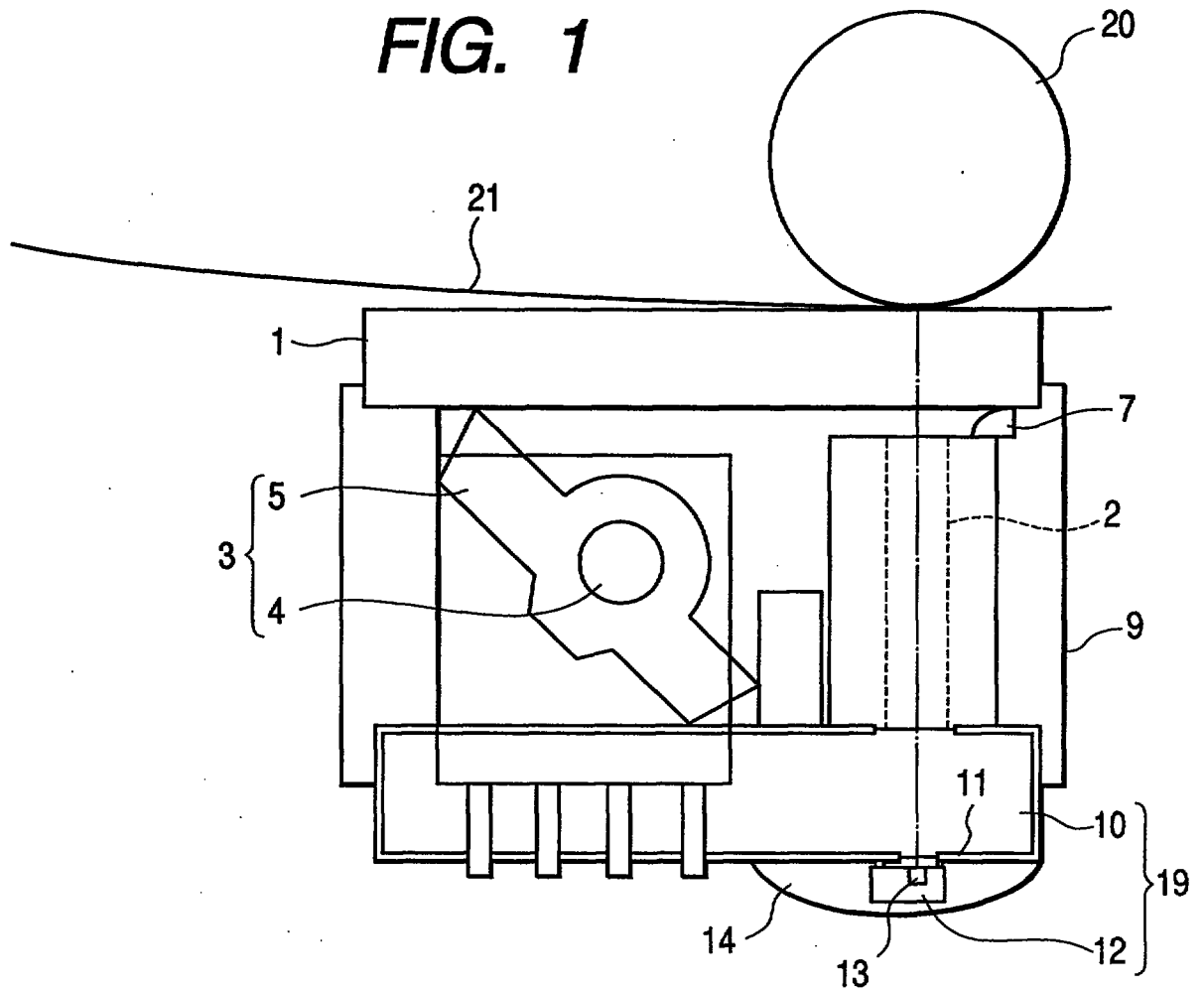
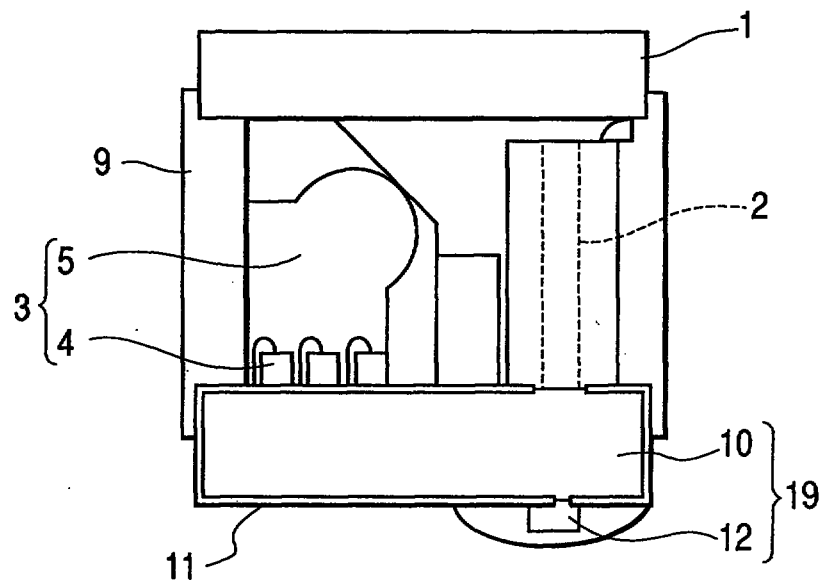
**FIG. 1****FIG. 3**

FIG. 2A

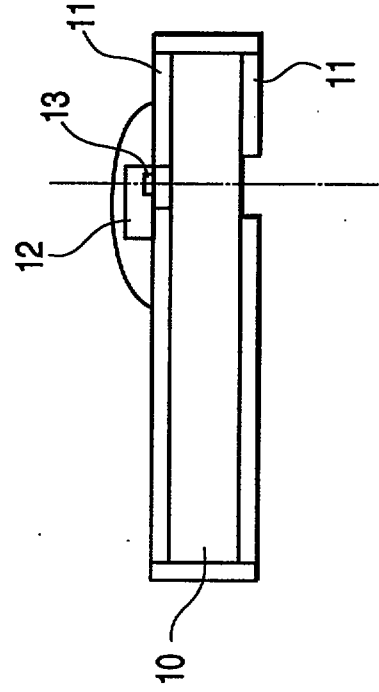
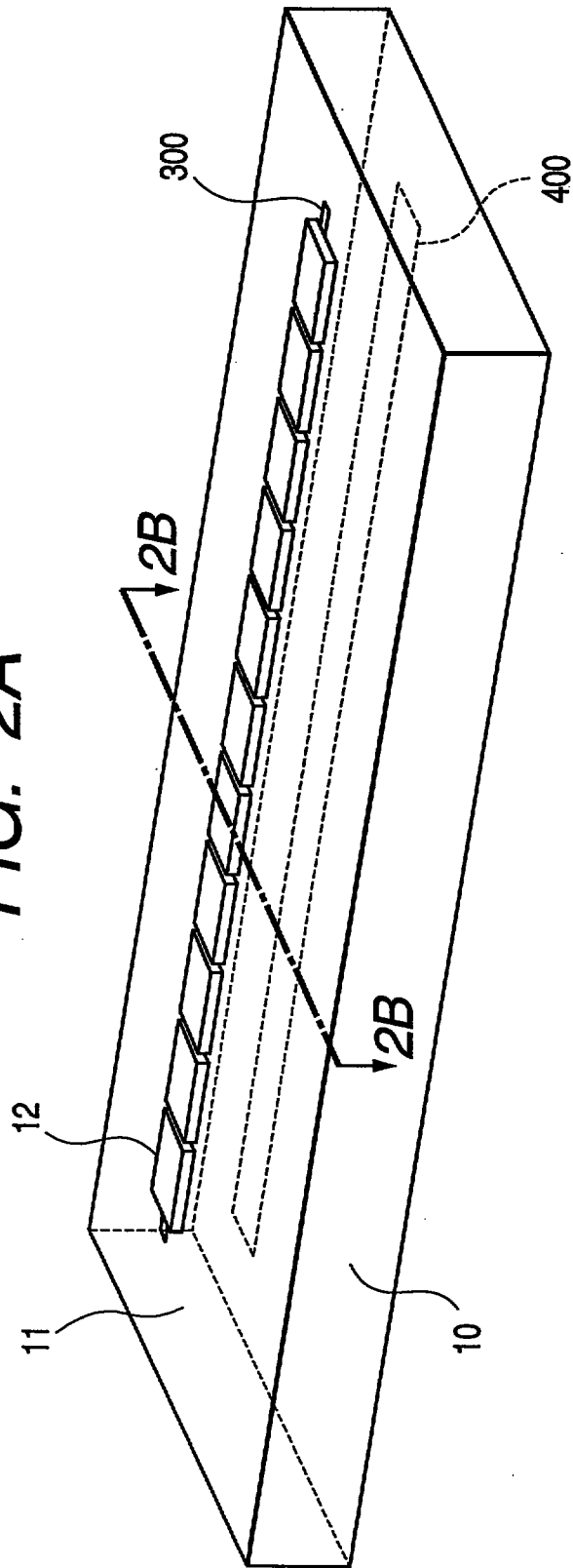
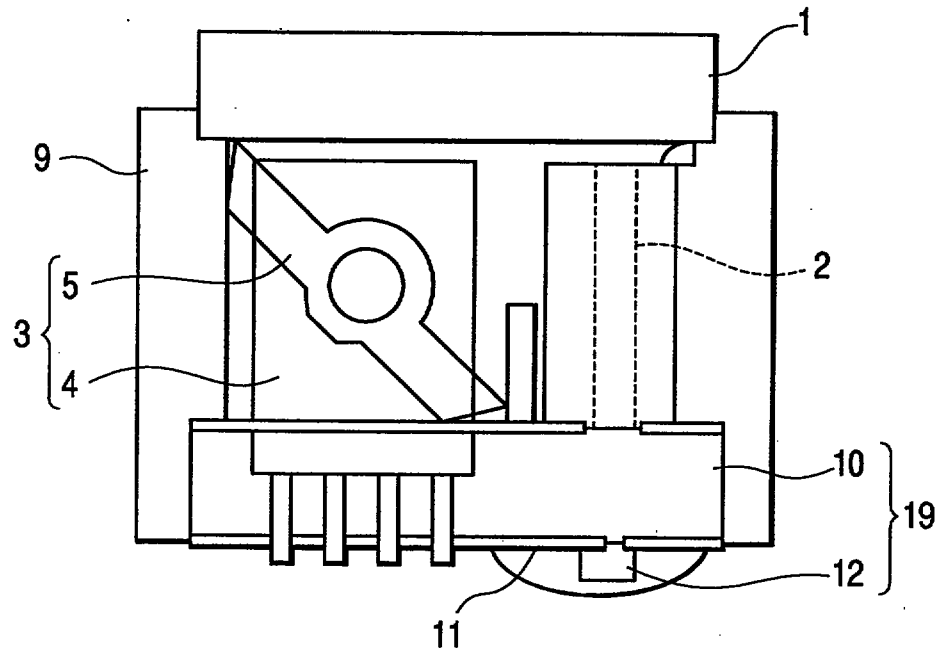
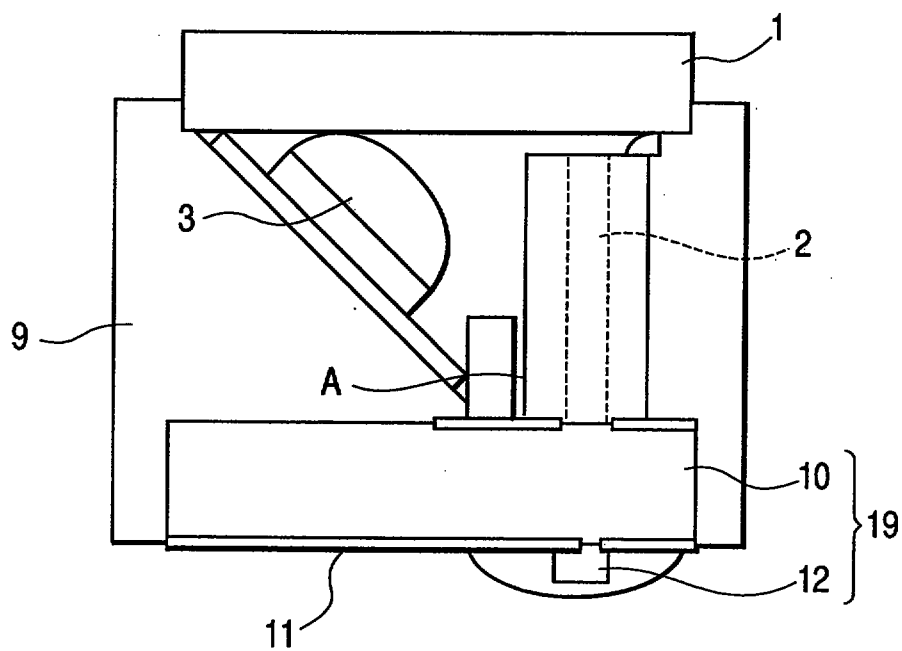
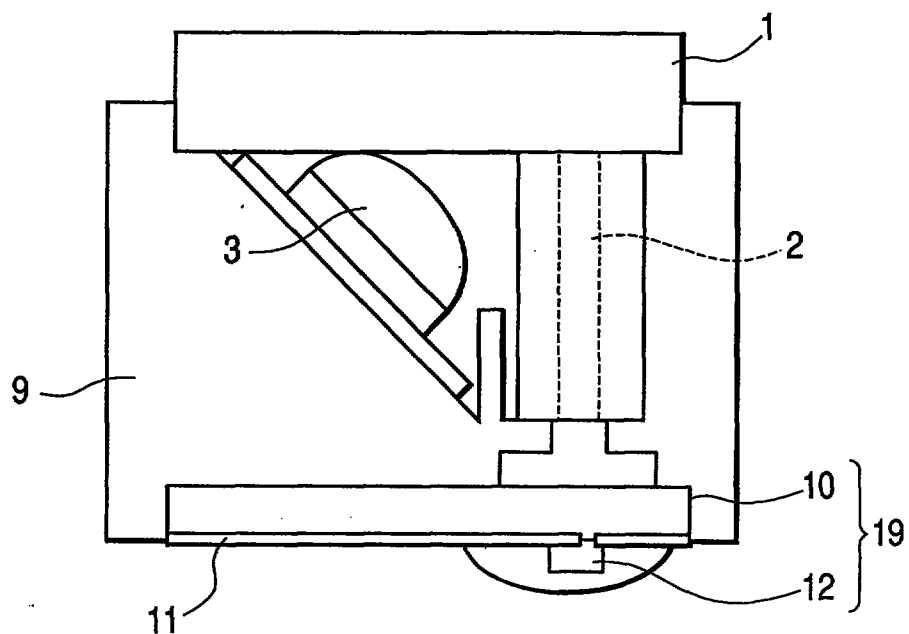


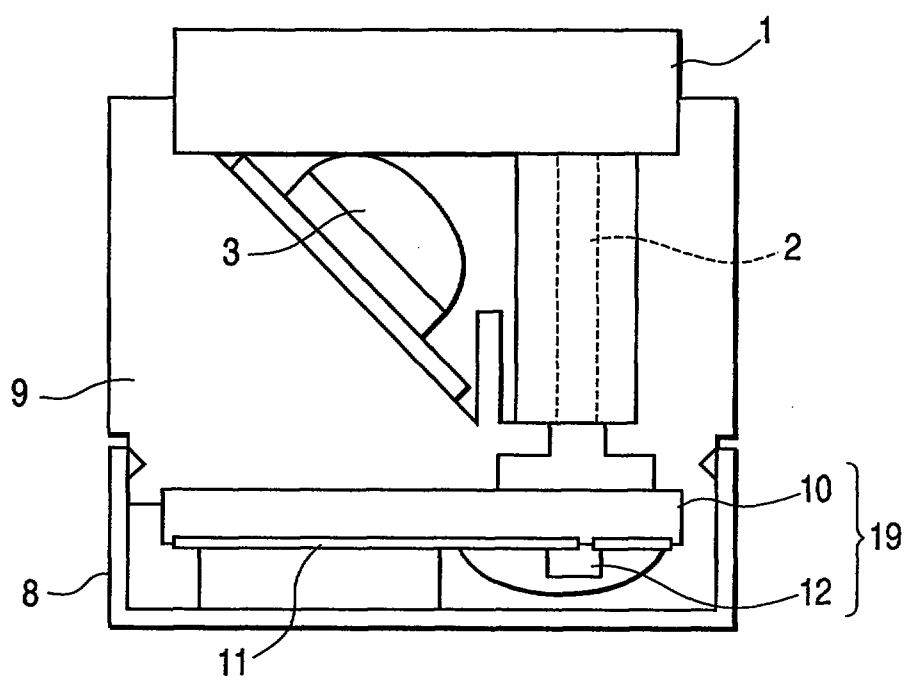
FIG. 2B

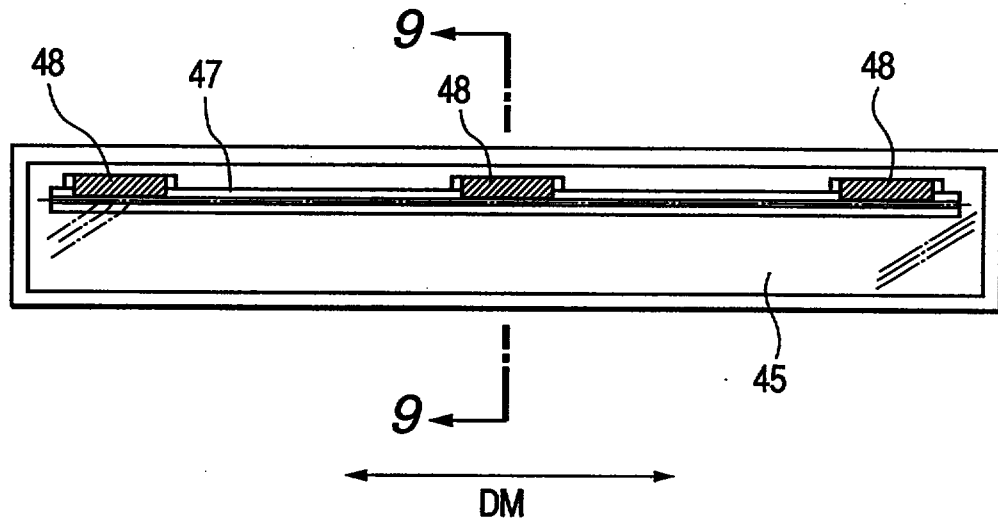
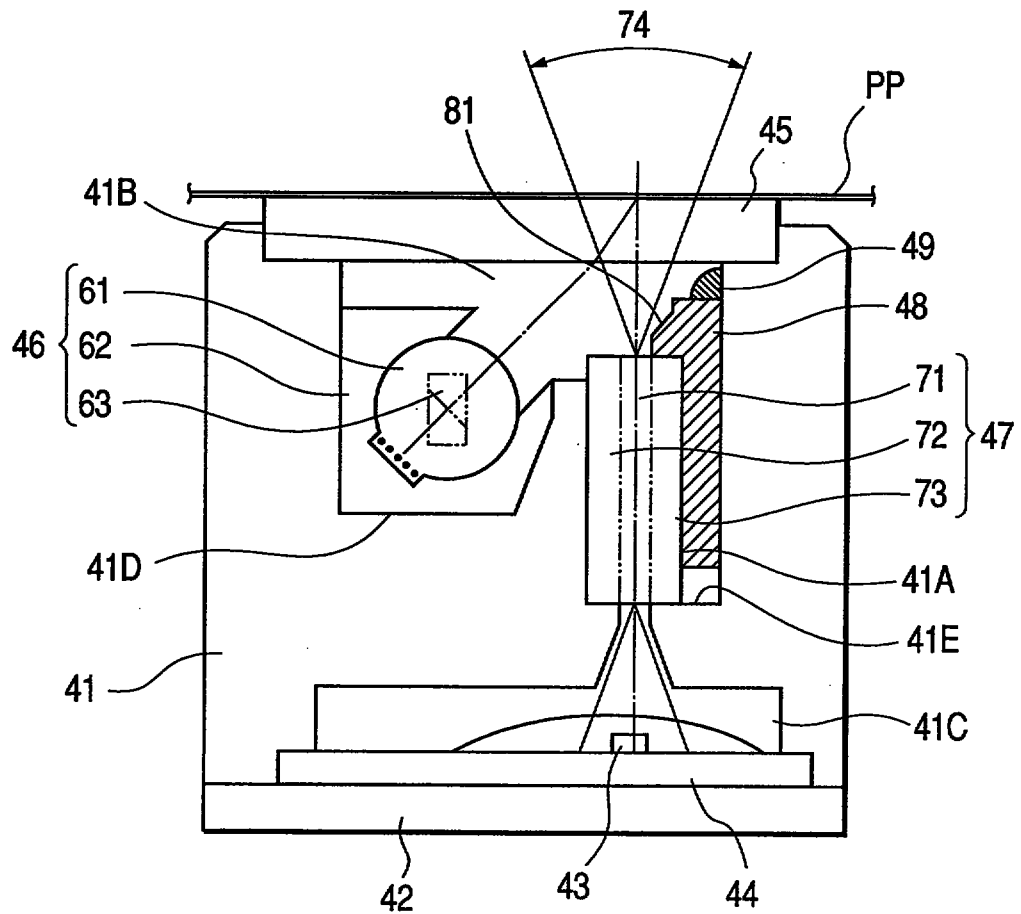
**FIG. 4****FIG. 5**

**FIG. 6**

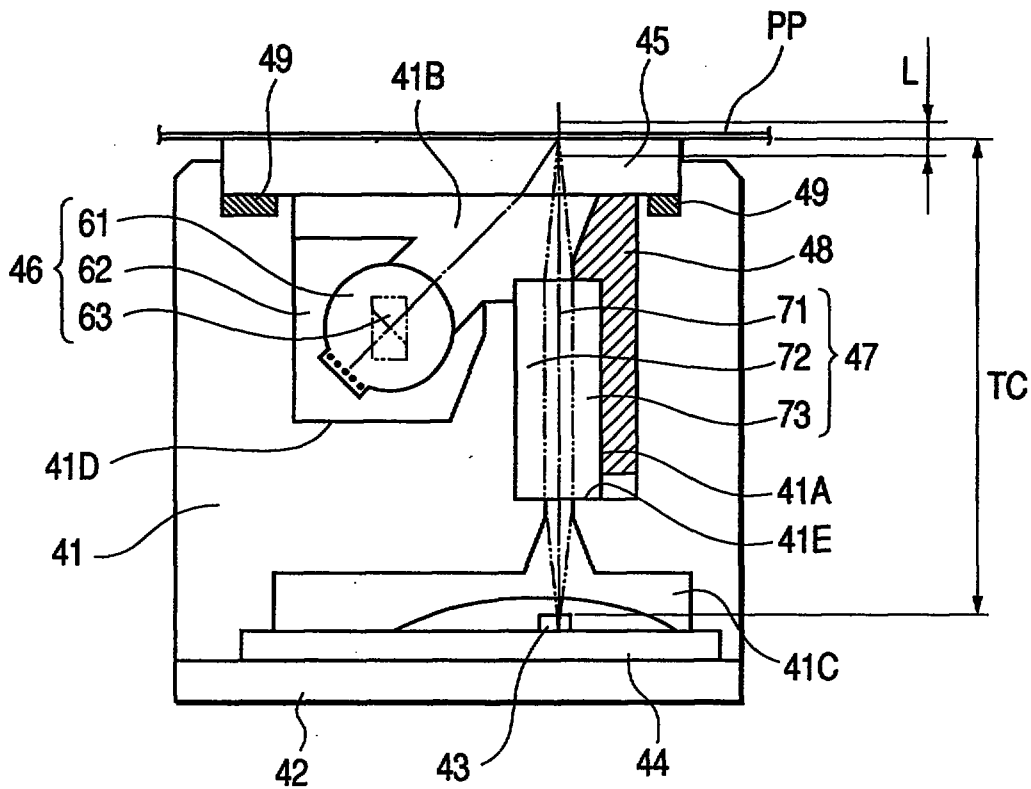


**FIG. 7**

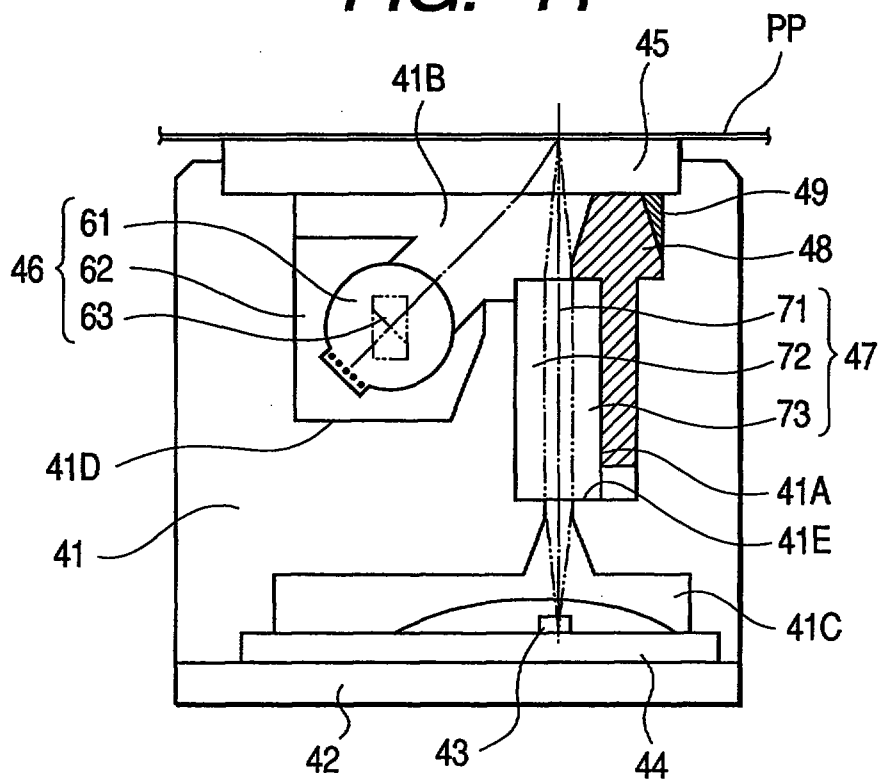


**FIG. 8****FIG. 9**

**FIG. 10**



**FIG. 11**



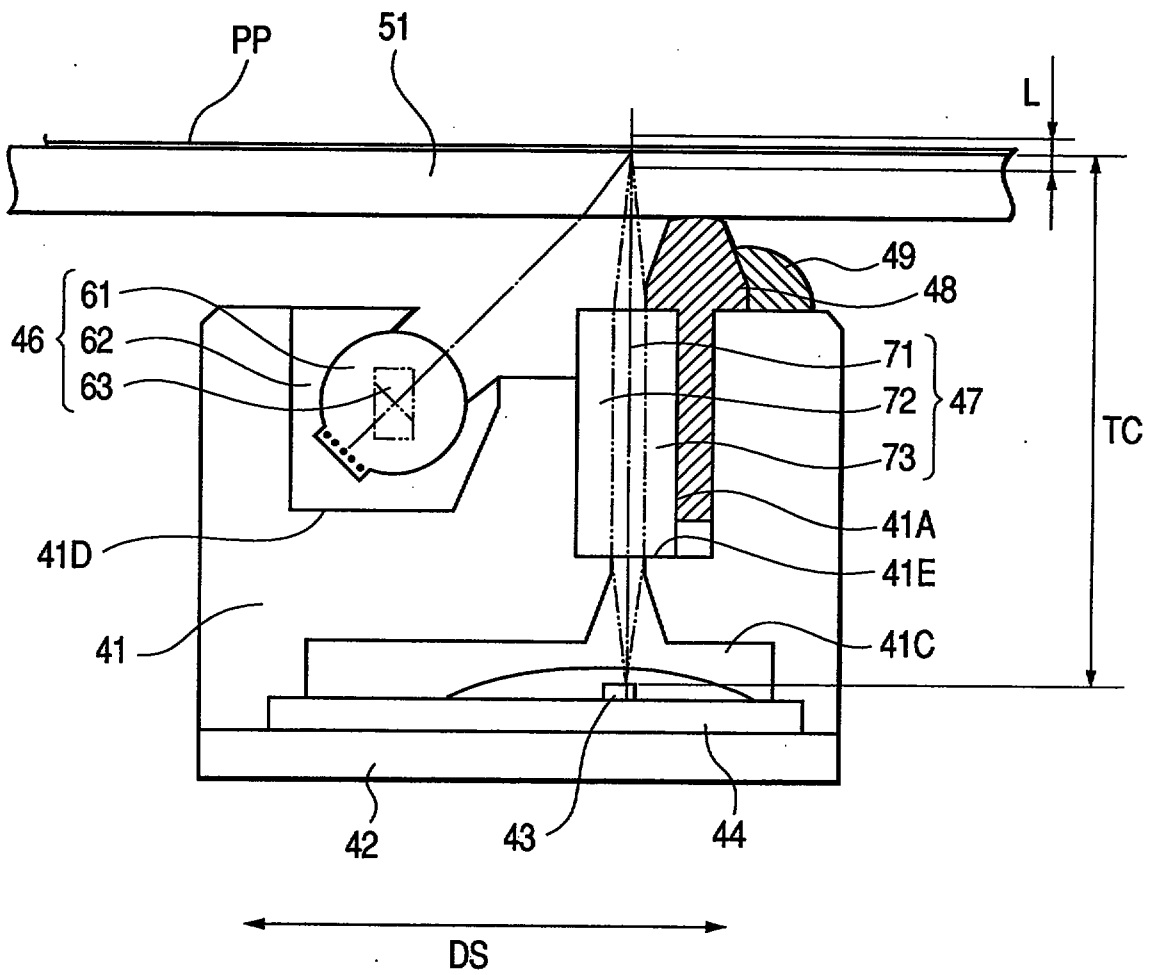
**FIG. 12**

FIG. 13

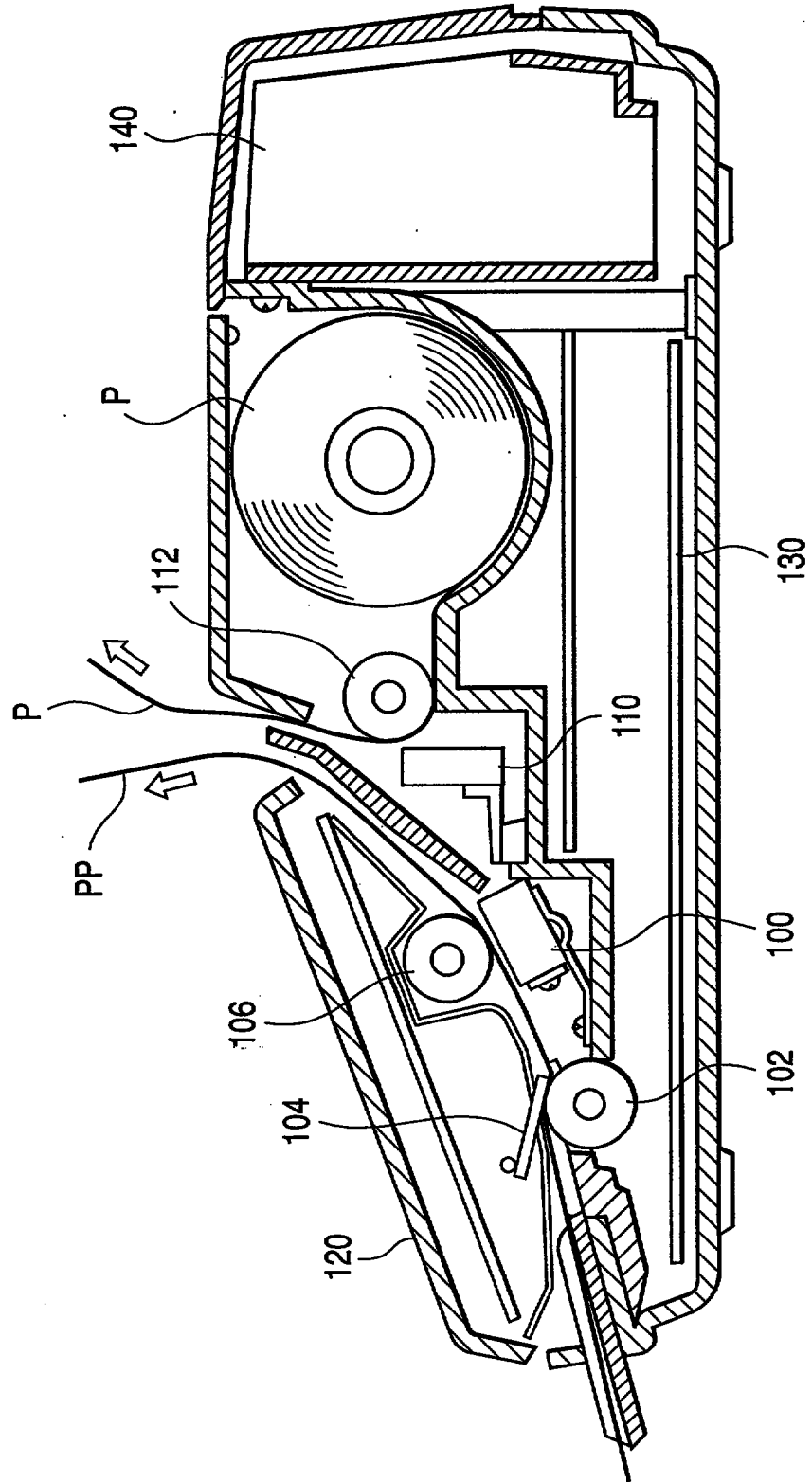
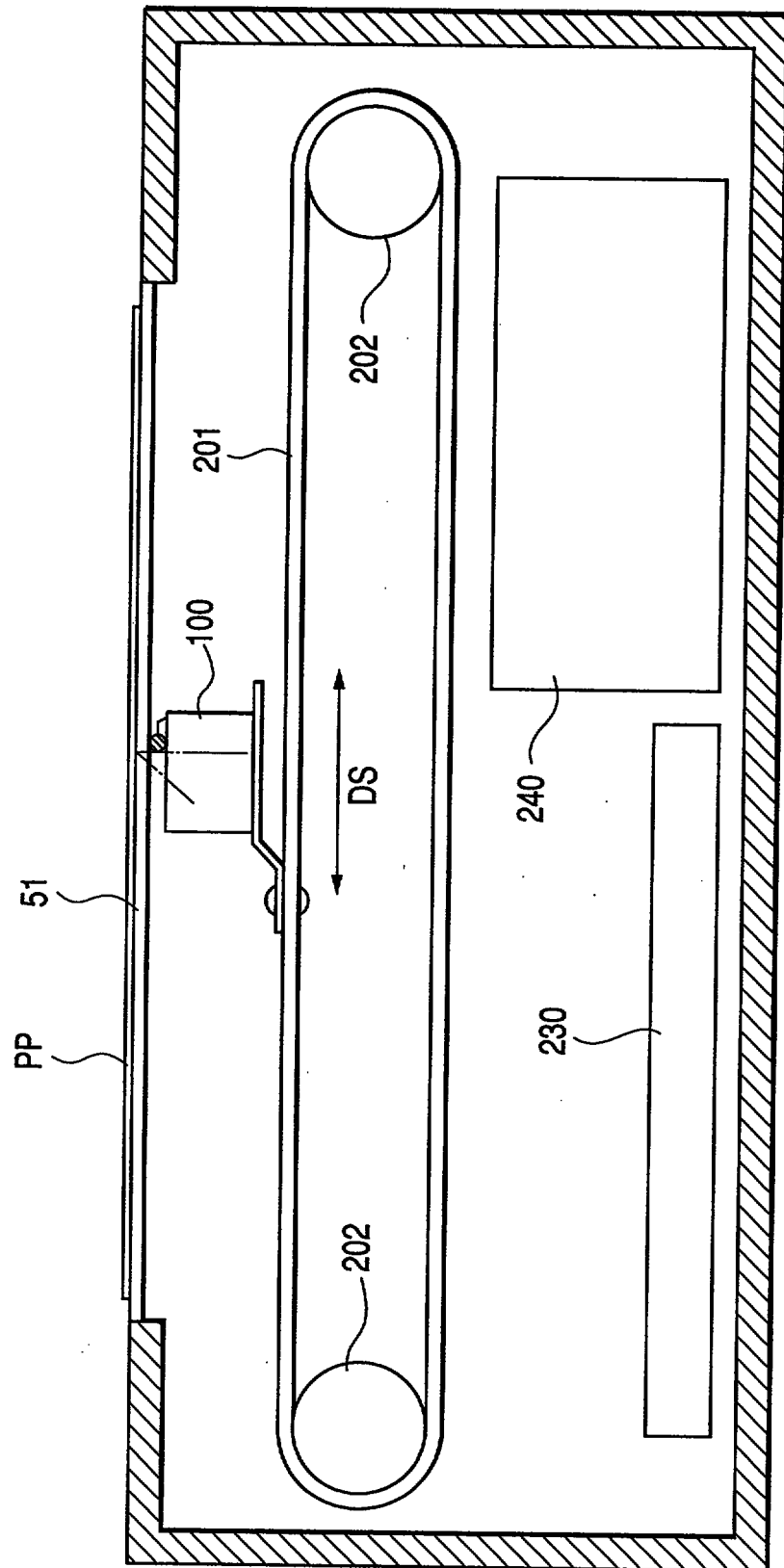
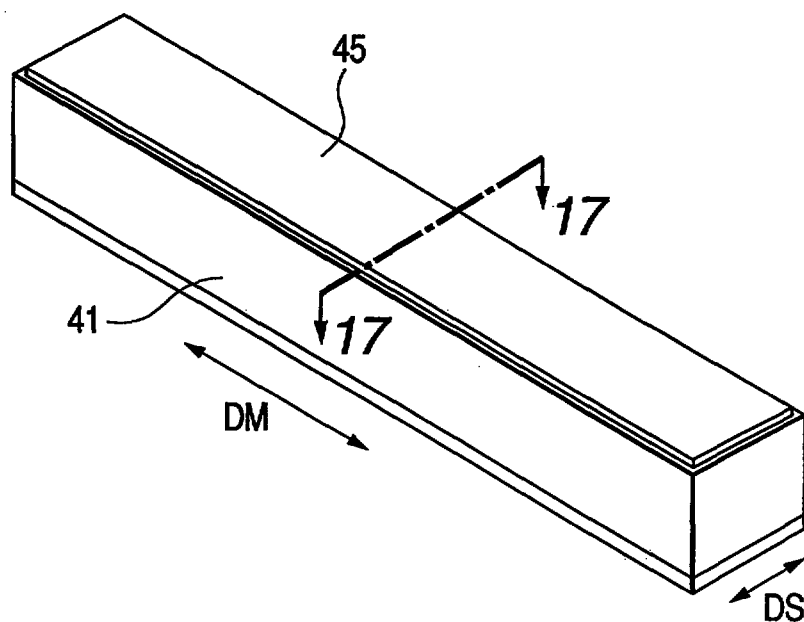
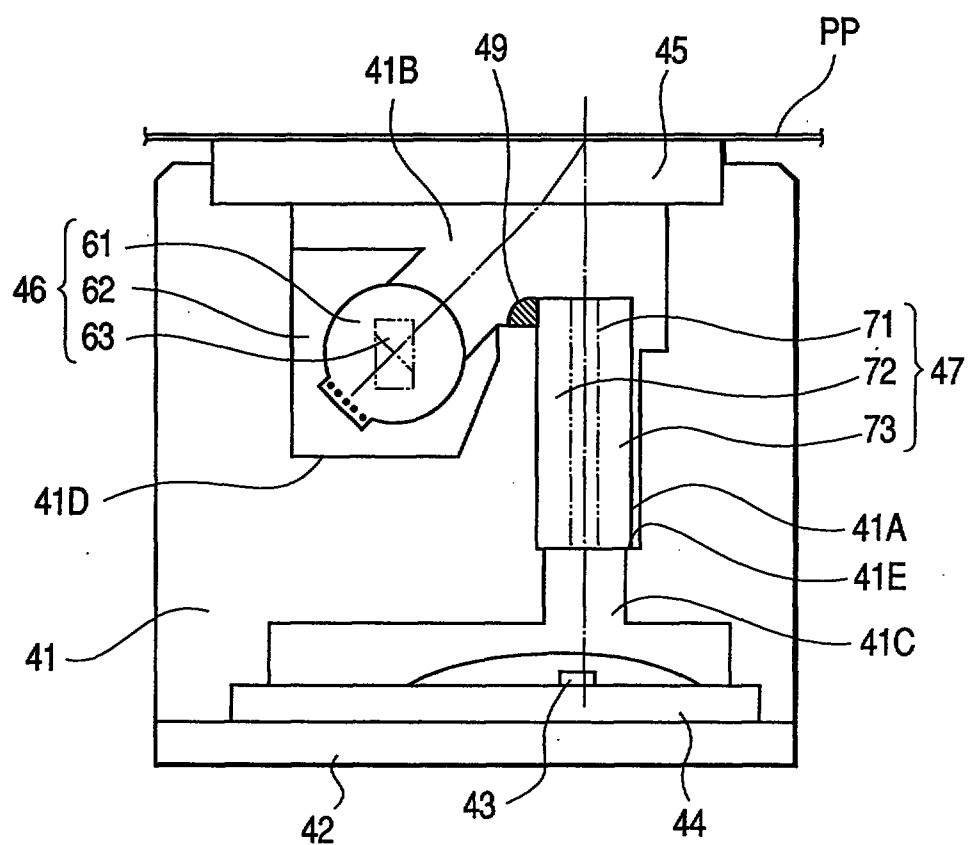
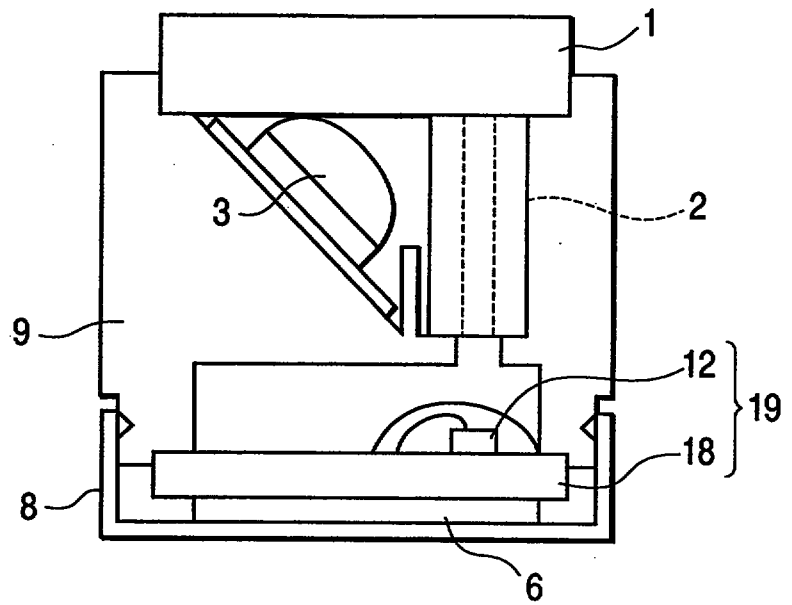


FIG. 14

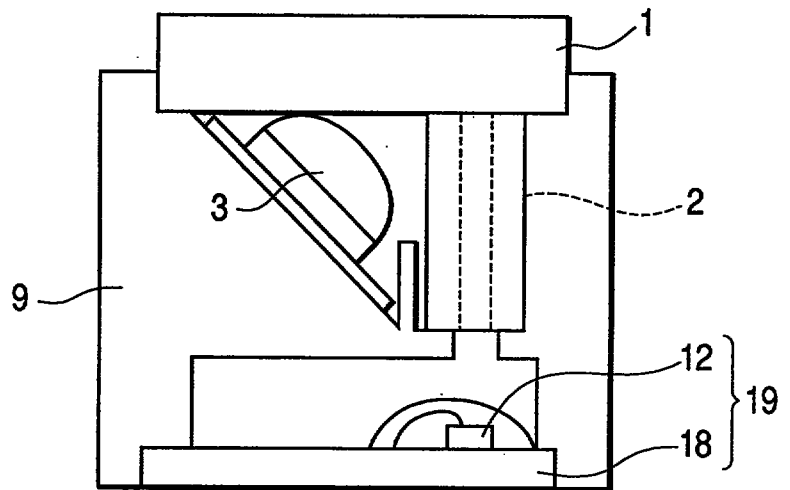


**FIG. 15****FIG. 17**

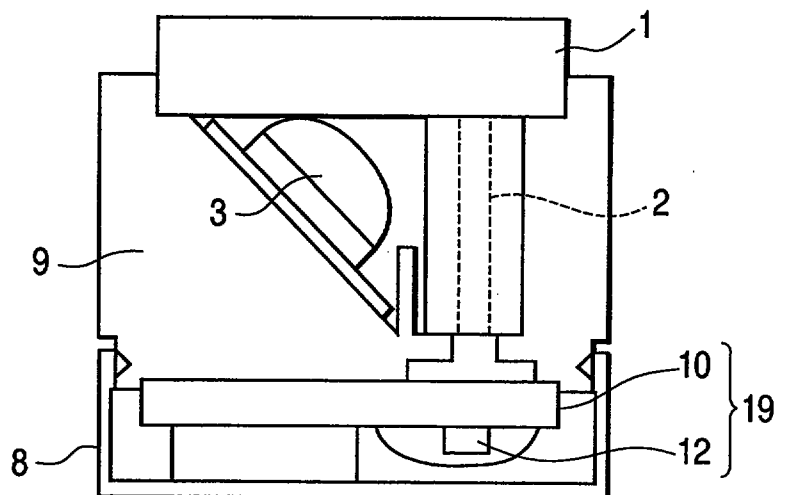
**FIG. 16A**

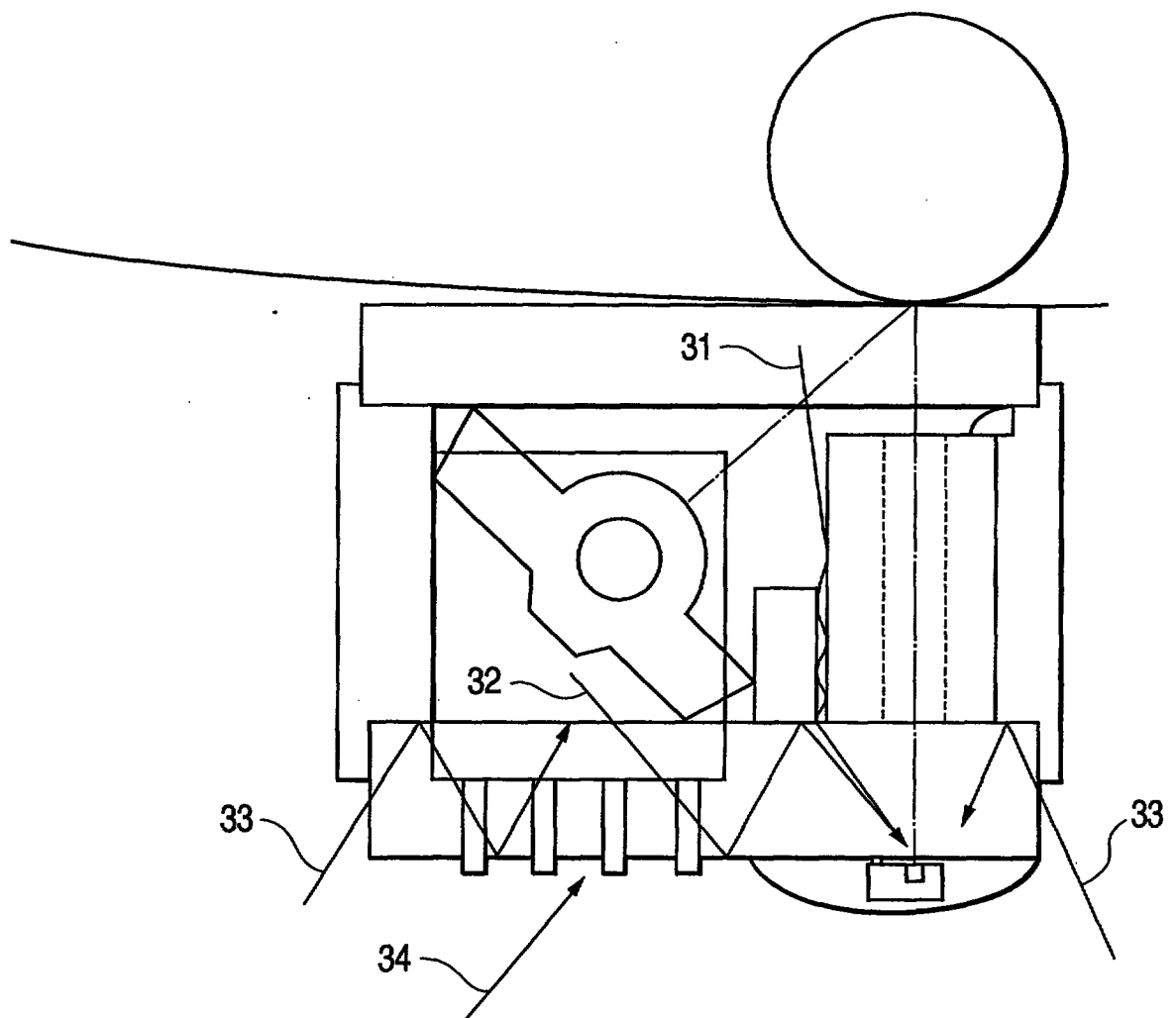


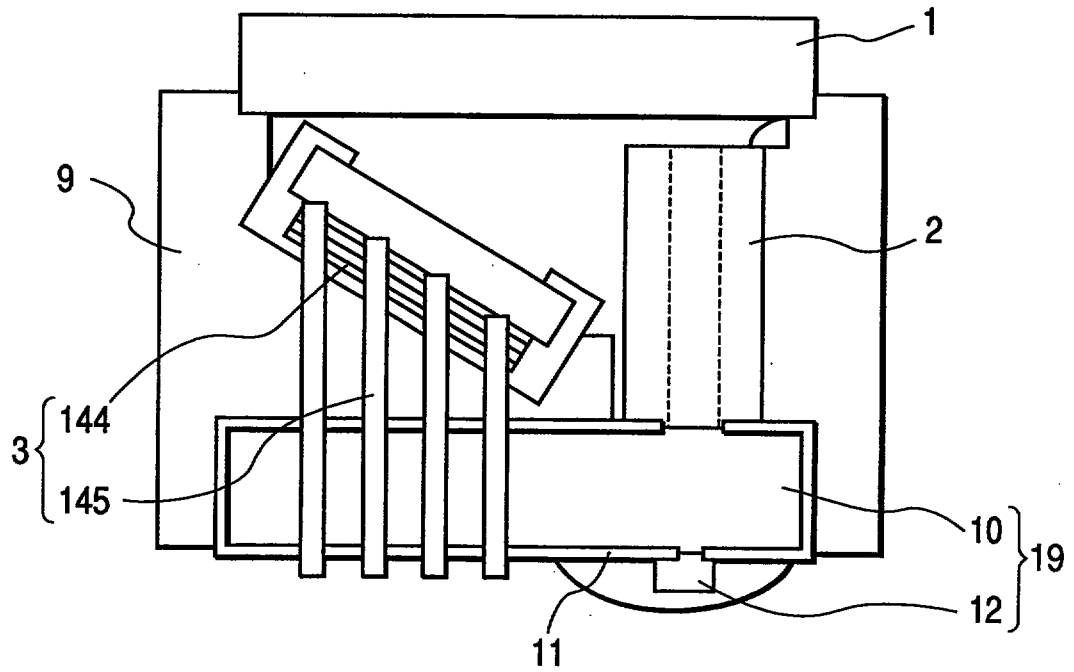
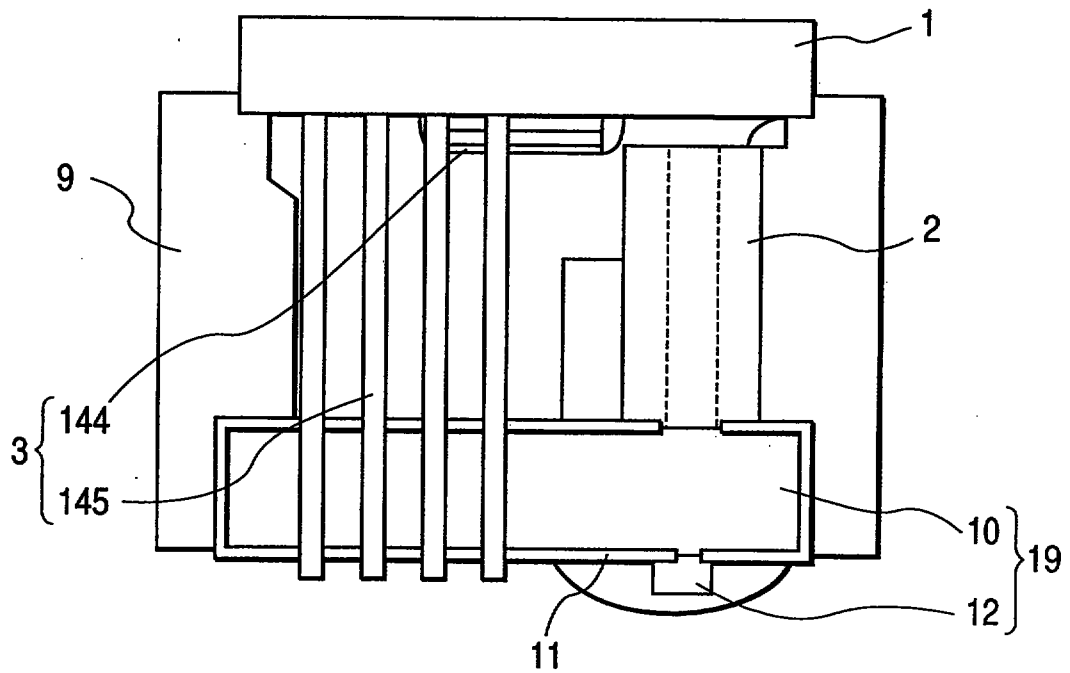
**FIG. 16B**

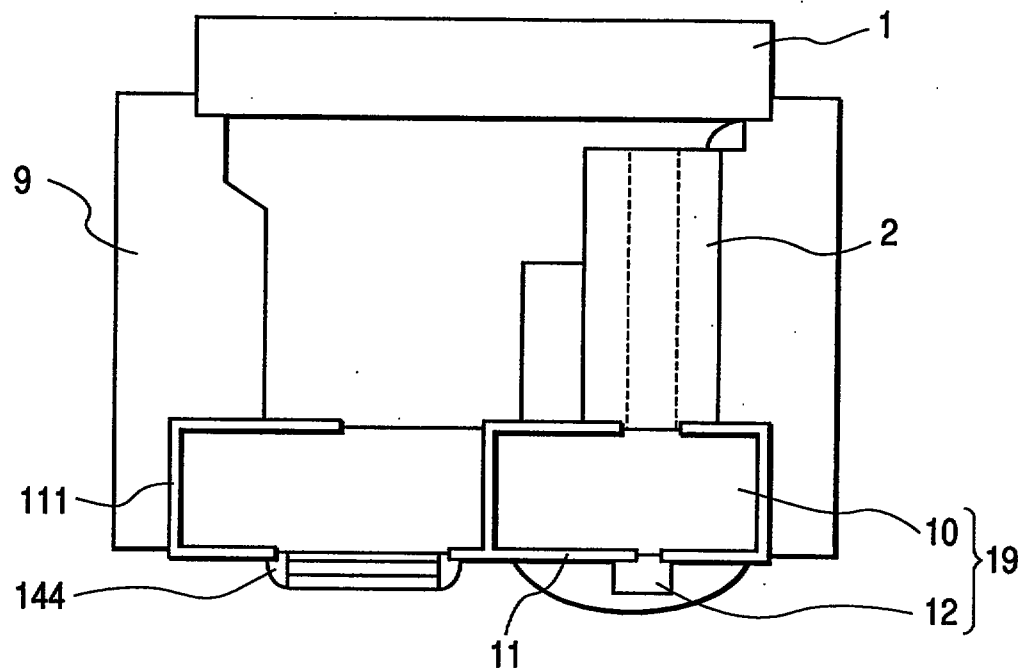
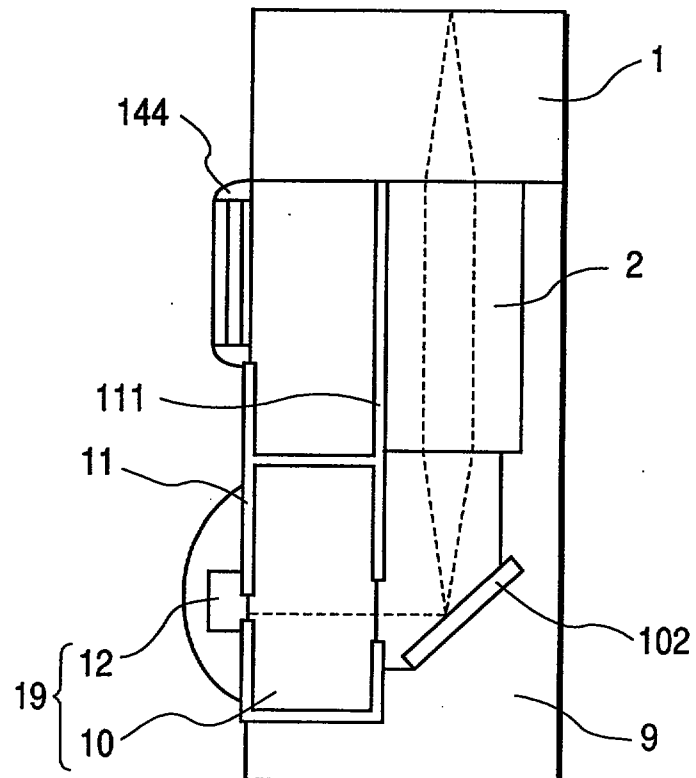


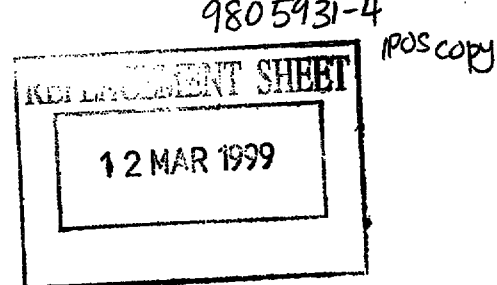
**FIG. 16C**



**FIG. 18**

**FIG. 19****FIG. 20**

**FIG. 21****FIG. 22**



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# CONTACT TYPE IMAGE SENSOR AND INFORMATION PROCESSING APPARATUS

## BACKGROUND OF THE INVENTION

### 5 Field of the Invention

The present invention relates to a contact type image sensor which reads an original from light reflected therefrom and can be used as an image pickup device of a facsimile, a copier, a scanner, and the like, and to an information processing apparatus using such a contact type image sensor.

### Related Background Art

As an example of an original reader used with a facsimile, a copier, a scanner, or the like, a contact type image sensor is known which focusses an image of the original at a magnification factor of 1 : 1 and reads the image having the same size as the original with a sensor array. Such a contact type image sensor is constituted of: a sensor substrate formed with a plurality of sensor chips each having a plurality of pixels for photoelectric conversion and a protective film for protecting the sensor chips; a rod lens array for focussing an image of an original upon pixels of the sensor chips; and a cover glass defining an original reading surface, respectively mounted on a frame.

Fig. 15 is a schematic perspective view of a

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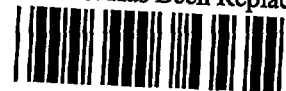
CONTACT TYPE IMAGE SENSOR AND INFORMATION PROCESSING APPARATUS

ABSTRACT OF THE DISCLOSURE

In a contact type image sensor having a sensor array mounting photosensors, a focussing unit for focussing light from an original upon the photosensors, and a frame for holding in position the sensor array and focussing unit, the focussing unit abuts on the sensor array. In a contact type image sensor having a sensor array having a plurality of face-down sensor chips with a plurality of pixels mounted on a transparent substrate in line, a rod lens array for focussing light from an original, a light source for illuminating the original, and a frame for holding in position the sensor array, rod lens array, the transparent substrate is covered with a light shielding layer in an area other than an area on which the pixels of the sensor chips are mounted and an area corresponding to a focussing area of the rod lens array.

Figure 1

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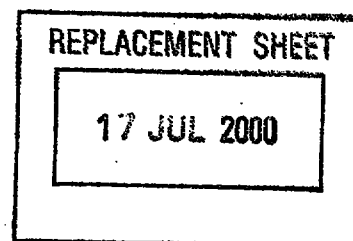


## TEXT OF THE ABSTRACT

CONTACT TYPE IMAGE SENSOR AND INFORMATION PROCESSING APPARATUS

In a contact type image sensor having a sensor array mounting photosensors (19), a focussing unit (2) for focussing light from an original (21) upon the photosensors (13), and a frame (9) for holding in position the sensor array (19) and focussing unit (2), the focussing unit (2) abuts on the sensor array. In a contact type image sensor having a sensor array (19) having a plurality of face-down sensor chips (12) with a plurality of pixels mounted on a transparent substrate (10) in line, a rod lens array (2) for focussing light from an original (21), a light source (3) for illuminating the original (21), and a frame (9) for holding in position the sensor array (19), rod lens array (2), the transparent substrate (10) is covered with a light shielding layer (11) in an area other than an area on which the pixels of the sensor chips (12) are mounted and an area corresponding to a focussing area of the rod lens array (2).

Figure 1.



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| <input type="checkbox"/>            | Drawing(s) : paged ..... to paged .....  |
| <input checked="" type="checkbox"/> | Abstract : paged ..... to paged 38       |
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WHAT IS CLAIMED IS:

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| <input checked="" type="checkbox"/> | Abstract : paged ..... to paged 38       |



1. A contact type image sensor comprising:
  - (a) a sensor substrate having photosensors mounted thereon, wherein said sensor substrate is transparent substrate;
  - (b) a focussing unit for focussing light from an original upon the photosensors; and
  - (c) a frame for holding said sensor substrate and said focussing unit,
 wherein said focussing unit contacts with said sensor substrate.
2. A contact type image sensor according to claim 1, wherein said transparent substrate has a light shielding layer.
3. A contact type image sensor according to claim 1, wherein said focussing unit is disposed on said transparent substrate on a side opposite to a side where the photosensors are mounted.
4. A contact type image sensor according to claim 3, wherein said transparent substrate has a light shielding layer.
5. A contact type image sensor according to claim 4, wherein said transparent substrate is not covered

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with the light shielding layer in an area corresponding to a focussing area of said focussing unit.

5 6. A contact type image sensor according to claim 4, wherein said transparent substrate is not covered with the light shielding layer in an area corresponding to an area where the photosensors are mounted and in an area corresponding to a focussing area of said focussing unit.

10

7. A contact type image sensor according to claim 6, wherein the light shielding layer is formed so that an area of the focussing area of said focussing unit becomes smaller than an area of light reception pixels  
15 of the photosensors.

8. A contact type image sensor according to claim 1, wherein said focussing unit is a rod lens.

20

9. An information processing apparatus comprising:

a contact type image sensor for reading an original image and outputting an image signal;

processing means for performing a predetermined  
25 process relative to the image signal output from said contact type image sensor; and

control means for controlling said contact type

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image sensor and said processing means,

wherein said contact type image sensor comprises:  
a sensor substrate having photosensors mounted thereon,  
wherein said sensor substrate is transparent substrate;  
5 a focussing unit for focussing light from an original  
upon the photosensors; and a frame for holding said  
sensor substrate and said focussing unit, wherein said  
focussing unit contacts with said sensor substrate.

10 10. An information processing apparatus according  
to claim 9, wherein said transparent substrate has a  
light shielding layer.

15 11. An information processing apparatus according  
to claim 9, wherein said focussing unit is disposed on  
said transparent substrate on a side opposite to a side  
where the photosensors are mounted.

20 12. An information processing apparatus according  
to claim 11, wherein said transparent substrate has a  
light shielding layer.

25 13. An information processing apparatus according  
to claim 12, wherein said transparent substrate is not  
covered with the light shielding layer in an area  
corresponding to a focussing area of said focussing  
unit.

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14. An information processing apparatus according to claim 12, wherein said transparent substrate is not covered with the light shielding layer in an area corresponding to an area where the photosensors are mounted and in an area corresponding to a focussing area of said focussing unit.

15. An information processing apparatus according to claim 14, wherein the light shielding layer is formed so that an area of the focussing area of said focussing unit becomes smaller than an area of light reception pixels of the photosensors.

16. An information processing apparatus according to claim 9, wherein said focussing unit is a rod lens.

17. A contact type image sensor comprising:

- (a) photosensors;
- (b) a support member for supporting an original;
- (c) a focussing unit for focussing light from the original upon the photosensors;
- (d) a frame for holding said photosensors, said focussing unit, and said support member; and
- (e) a focussing unit holding member disposed between said support member and said focussing unit, for positioning said focussing unit relative to said frame; and

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(f) fixing means for fixing said frame and said focussing unit holding member.

18. A contact type image sensor according to  
5 claim 17, wherein said focussing unit is inserted into a space between, and squeezed between, said focussing unit holding member and said frame.

19. A contact type image sensor according to  
10 claim 17, wherein said support member is fixed to said frame with adhesive.

20. A contact type image sensor according to  
claim 19, wherein said support member together with  
15 said focussing unit holding member is fixed to said frame with adhesive.

21. A contact type image sensor according to  
claim 17, wherein said focussing unit holding member is  
20 positioned outside of an opening angle of said focussing unit.

22. A contact type image sensor according to  
claim 17, wherein a thickness in an optical path  
25 direction of said focussing unit holding member between said support member and said focussing unit is set so that an original support surface of said support member





is positioned in a range of a depth of focus of said focussing unit, and said focussing unit holding member abuts on said support member and said focussing unit.

5           23. An information processing apparatus comprising:

          a contact type image sensor for reading an original image and outputting an image signal;

          processing means for performing a predetermined  
10 process relative to the image signal output from said contact type image sensor; and

          control means for controlling said contact type image sensor and said processing means,

          wherein said contact type image sensor comprises:  
15 photosensors; a support member for supporting an original; a focussing unit for focussing light from the original upon the photosensors; a frame for holding said photosensors, said focussing unit, and said support member; and a focussing unit holding member  
20 disposed between said support member and said focussing unit, for positioning said focussing unit relative to said frame; and fixing means for fixing said frame and said focussing unit holding member.

25           24. An information processing apparatus according to claim 23, wherein said focussing unit is inserted into a space between, and squeezed between, said





focussing unit holding member and said frame.

25. An information processing apparatus according to claim 23, wherein said support member is fixed to  
5 said frame with adhesive.

26. An information processing apparatus according to claim 25, wherein said support member together with said focussing unit holding member is fixed to said  
10 frame with adhesive.

27. An information processing apparatus according to claim 23, wherein said focussing unit holding member is positioned outside of an opening angle of said  
15 focussing unit.

28. An information processing apparatus according to claim 23, wherein a thickness in an optical path direction of said focussing unit holding member between  
20 said support member and said focussing unit is set so that an original support surface of said support member is positioned in a range of a depth of focus of said focussing unit, and said focussing unit holding member abuts on said support member and said focussing unit.

25

29. A contact type image sensor according to claim 17, wherein said focussing unit holding member is

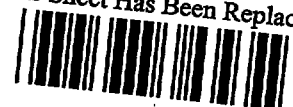




positioned and fixed by joining said support member and  
said focussing unit holding member.

5        30. An information processing apparatus according  
to claim 23, wherein said focussing unit holding member  
is positioned and fixed by joining said support member  
and said focussing unit holding member.

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CONTACT TYPE IMAGE SENSOR AND INFORMATION PROCESSING  
APPARATUS

ABSTRACT OF THE DISCLOSURE

5           In a contact type image sensor having a sensor  
array mounting photosensors (19), a focussing unit (2)  
for focussing light from an original (21) upon the  
photosensors (13), and a frame (9) for holding in  
position the sensor array (19) and focussing unit (2),  
10   the focussing unit (2) abuts on the sensor array. In a  
contact type image sensor having a sensor array (19)  
having a plurality of face-down sensor chips (12) with  
a plurality of pixels mounted on a transparent  
substrate (10) in line, a rod lens array (2) for  
15   focussing light from an original (21), a light source  
(3) for illuminating the original (21), and a frame (9)  
for holding in position the sensor array (19), rod lens  
array (2), the transparent substrate (10) is covered  
with a light shielding layer (11) in an area other than  
20   an area on which the pixels of the sensor chips (12)  
are mounted and an area corresponding to a focussing  
area of the rod lens array (2).

Figure 1

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| <input checked="" type="checkbox"/> | Abstract : paged .... to paged 37      |
| DATE OF RECEIPT 03.09.01            |                                        |

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WHAT IS CLAIMED IS:

1. A contact type image sensor comprising:
  - (a) a sensor substrate having photosensors mounted thereon, wherein said sensor substrate is transparent  
5 substrate and has a light shielding layer;
  - (b) a focussing unit for focussing light from an original upon the photosensors; and
  - (c) a frame for holding said sensor substrate and  
said focussing unit,  
10 wherein said focussing unit contacts with said sensor substrate.
2. A contact type image sensor according to claim 1, wherein said focussing unit is disposed on said  
15 transparent substrate on a side opposite to a side where the photosensors are mounted.
3. A contact type image sensor according to claim 1, wherein said transparent substrate is not covered  
20 with the light shielding layer in an area corresponding to a focussing area of said focussing unit.
4. A contact type image sensor according to claim 1, wherein said transparent substrate is not covered  
25 with the light shielding layer in an area corresponding to an area where the photosensors are mounted and in an area corresponding to a focussing area of said



focussing unit.

5        5. A contact type image sensor according to claim  
4, wherein the light shielding layer is formed so that  
an area of the focussing area of said focussing unit  
becomes smaller than an area of light reception pixels  
of the photosensors.

10       6. A contact type image sensor according to claim  
1, wherein said focussing unit is a rod lens.

7. An information processing apparatus  
comprising:

15       a contact type image sensor for reading an  
original image and outputting an image signal;

      processing means for performing a predetermined  
process relative to the image signal output from said  
contact type image sensor; and

20       control means for controlling said contact type  
image sensor and said processing means,

      wherein said contact type image sensor comprises:  
a sensor substrate having photosensors mounted thereon,  
wherein said sensor substrate is transparent substrate  
and has a light shielding layer; a focussing unit for  
25       focussing light from an original upon the photosensors;  
and a frame for holding said sensor substrate and said  
focussing unit, wherein said focussing unit contacts



with said sensor substrate.

8. An information processing apparatus according to claim 7, wherein said focussing unit is disposed on said transparent substrate on a side opposite to a side where the photosensors are mounted.

9. An information processing apparatus according to claim 7, wherein said transparent substrate is not covered with the light shielding layer in an area corresponding to a focussing area of said focussing unit.

10. An information processing apparatus according to claim 7, wherein said transparent substrate is not covered with the light shielding layer in an area corresponding to an area where the photosensors are mounted and in an area corresponding to a focussing area of said focussing unit.

11. An information processing apparatus according to claim 10, wherein the light shielding layer is formed so that an area of the focussing area of said focussing unit becomes smaller than an area of light reception pixels of the photosensors.

12. An information processing apparatus according



to claim 7, wherein said focussing unit is a rod lens.

13. A contact type image sensor comprising:

(a) photosensors;

5 (b) a support member for supporting an original;

(c) a focussing unit for focussing light from the original upon the photosensors;

(d) a frame for holding said photosensors, said focussing unit, and said support member;

10 (e) a focussing unit holding member different from said support member and disposed between said support member and said focussing unit, for positioning said focussing unit relative to said frame in an optical path direction of said focussing unit; and

15 (f) fixing means for fixing said frame and said focussing unit holding member.

14. A contact type image sensor according to claim 13, wherein said focussing unit is inserted into  
20 a space between, and squeezed between, said focussing unit holding member and said frame.

15. A contact type image sensor according to claim 13, wherein said support member is fixed to said  
25 frame with adhesive.

16. A contact type image sensor according to

claim 15, wherein said support member together with said focussing unit holding member is fixed to said frame with adhesive.

5           17. A contact type image sensor according to claim 13, wherein said focussing unit holding member is positioned outside of an opening angle of said focussing unit.

10           18. A contact type image sensor according to claim 13, wherein a thickness in an optical path direction of said focussing unit holding member between said support member and said focussing unit is set so that an original support surface of said support member  
15           is positioned in a range of a depth of focus of said focussing unit, and said focussing unit holding member abuts on said support member and said focussing unit.

            19. An information processing apparatus  
20           comprising:

            a contact type image sensor for reading an original image and outputting an image signal;

            processing means for performing a predetermined process relative to the image signal output from said  
25           contact type image sensor; and

            control means for controlling said contact type image sensor and said processing means,



wherein said contact type image sensor comprises:  
photosensors; a support member for supporting an  
original; a focussing unit for focussing light from the  
original upon the photosensors; a frame for holding  
5 said photosensors, said focussing unit, and said  
support member; a focussing unit holding member  
different from said support member and disposed between  
said support member and said focussing unit, for  
positioning said focussing unit relative to said frame  
10 in an optical path direction of said focusing unit; and  
fixing means for fixing said frame and said focussing  
unit holding member.

20. An information processing apparatus according  
15 to claim 19, wherein said focussing unit is inserted  
into a space between, and squeezed between, said  
focussing unit holding member and said frame.

21. An information processing apparatus according  
20 to claim 19, wherein said support member is fixed to  
said frame with adhesive.

22. An information processing apparatus according  
to claim 21, wherein said support member together with  
25 said focussing unit holding member is fixed to said  
frame with adhesive.



23. An information processing apparatus according to claim 19, wherein said focussing unit holding member is positioned outside of an opening angle of said focussing unit.

5

24. An information processing apparatus according to claim 19, wherein a thickness in an optical path direction of said focussing unit holding member between said support member and said focussing unit is set so  
10 that an original support surface of said support member is positioned in a range of a depth of focus of said focussing unit, and said focussing unit holding member abuts on said support member and said focussing unit.

15

25. A contact type image sensor according to claim 13, wherein said focussing unit holding member is positioned and fixed by joining said support member and said focussing unit holding member.

20

26. An information processing apparatus according to claim 19, wherein said focussing unit holding member is positioned and fixed by joining said support member and said focussing unit holding member.

CONTACT TYPE IMAGE SENSOR AND INFORMATION PROCESSING  
APPARATUS

ABSTRACT OF THE DISCLOSURE

5           In a contact type image sensor having a sensor  
array mounting photosensors (19), a focussing unit (2)  
for focussing light from an original (21) upon the  
photosensors (13), and a frame (9) for holding in  
position the sensor array (19) and focussing unit (2),  
10   the focussing unit (2) abuts on the sensor array. In a  
contact type image sensor having a sensor array (19)  
having a plurality of face-down sensor chips (12) with  
a plurality of pixels mounted on a transparent  
substrate (10) in line, a rod lens array (2) for  
15   focussing light from an original (21), a light source  
(3) for illuminating the original (21), and a frame (9)  
for holding in position the sensor array (19), rod lens  
array (2), the transparent substrate (10) is covered  
with a light shielding layer (11) in an area other than  
20   an area on which the pixels of the sensor chips (12)  
are mounted and an area corresponding to a focussing  
area of the rod lens array (2).

Figure 1